

# 8-bit Proprietary Microcontroller

CMOS

## F<sup>2</sup>MC-8L MB89490 Series

### MB89498/F499/PV490

#### ■ DESCRIPTION

The MB89490 series has been developed as a general-purpose version of the F<sup>2</sup>MC\*-8L family consisting of proprietary 8-bit single-chip microcontrollers.

In addition to a compact instruction set, the general-purpose, single-chip microcontroller contains a variety of peripheral functions such as 21-bit timebase timer, watch prescaler, PWM timer, 8/16-bit timer/counter, remote receiver circuit, LCD controller/driver, external interrupt 0 (edge), external interrupt 1 (level), 10-bit A/D converter, UART/SIO, SIO, I<sup>2</sup>C and watchdog timer reset.

The MB89490 series is designed suitable for compact disc/radio receiver controller as well as in a wide range of applications for consumer product.

\* : F<sup>2</sup>MC is the abbreviation for Fujitsu Flexible Microcontroller.

#### ■ FEATURES

- Package  
QFP, LQFP package for MB89F499, MB89498  
MQFP package for MB89PV490

(Continued)

For the information for microcontroller supports, see the following web site.

<http://edevice.fujitsu.com/micom/en-support/>

# MB89490 Series

(Continued)

- High speed operating capability at low voltage
- Minimum execution time : 0.32  $\mu$ s/12.5 MHz
- F<sup>2</sup>MC-8L family CPU core

Instruction set optimized for controllers {

- Multiplication and division instructions
- 16-bit arithmetic operations
- Branch instructions by test bit
- Bit manipulation instructions, etc.

- PLL circuit for sub-clock
  - Embedded for PLL clock multiplication circuit for sub-clock
  - Operating clock (PLL for sub-clock) can be selected from no multiplication or 4 times of the sub-clock oscillation frequency.
- 6 timers
  - PWM timer  $\times$  2
  - 8/16-bit timer/counter  $\times$  2
  - 21-bit timebase timer
  - Watch prescaler
- External interrupt
  - Edge detection (selectable edge) : 8 channels
  - Low level interrupt (wake-up function) : 8 channels
- 10-bit A/D converter (8 channels)
  - 10-bit successive approximation type
- UART/SIO
  - Synchronous/asynchronous data transfer capability
- SIO
  - Switching of synchronous data transfer capability
- LCD controller/driver
  - Max 32 segments output  $\times$  4 commons
- I<sup>2</sup>C interface circuit
- Remote receiver circuit
- Low-power consumption mode
  - Stop mode (oscillation stops so as to minimize the current consumption.)
  - Sleep mode (CPU stops so as to reduce the current consumption to approx. 1/3 of normal.)
  - Watch mode (operation except the watch prescaler stops so as to reduce the power consumption to an extremely low level.)
  - Sub-clock mode
- Watchdog timer reset
- I/O ports : Max 66 channels

## ■ PRODUCT LINEUP

Part number Parameter	MB89498	MB89F499	MB89PV490
Classification	Mass production products (mask ROM product)	FLASH	Piggy-back (For evaluation or development)
ROM size	48 K × 8-bit (internal ROM)	60 K × 8-bit (internal FLASH)	60 K × 8-bit (external ROM) *
RAM size	2 K × 8-bit	2 K × 8-bit	2 K × 8-bit
CPU functions	Number of instructions : 136 Instruction bit length : 8-bit Instruction length : 1 to 3 bytes Data bit length : 1-bit, 8-bit, 16-bit Minimum instruction execution time : 0.32 μs/12.5 MHz Minimum interrupt processing time : 2.88 μs/12.5 MHz		
Ports	General-purpose I/O ports (CMOS) : 56 pins Input ports (CMOS) : 2 pins N-channel open drain I/O ports : 8 pins Total : 66 pins		
21-bit timebase timer	Interrupt generation cycle (0.66 ms, 2.6 ms, 21.0 ms, 335.5 ms) at 12.5 MHz		
Watchdog timer	Reset generation cycle (167.8 ms to 335.5 ms) at 12.5 MHz		
PWM timer 0, 1	8-bit reload timer operation (supports square wave output and operating clock period : 1 t <sub>inst</sub> , 8 t <sub>inst</sub> , 16 t <sub>inst</sub> , 64 t <sub>inst</sub> ) 8-bit accuracy PWM operation		
8/16-bit timer/counter 00, 01	Can be operated either as a 2-channel 8-bit timer/counter (timer 00 and timer 01, each with its own independent operating clock) , or as one 16-bit timer/counter. In timer 00 or 16-bit timer/counter operation, event counter operation by external clock input and square wave output capability		
8/16-bit timer/counter 10, 11	Can be operated either as a 2-channel 8-bit timer/counter (timer 10 and timer 11, each with its own independent operating clock) , or as one 16-bit timer/counter. In timer 10-bit or 16-bit timer/counter operation, event counter operation by external clock input and square wave output capability		
External interrupt 0 (edge)	8 independent channels (selectable edge, interrupt vector, request flag)		
External interrupt 1 (level)	8 channels (low level interrupt)		
A/D converter	10-bit accuracy × 8 channels A/D conversion function (conversion time : 30 t <sub>inst</sub> ) Supports repeated activation by internal clock		
LCD controller/driver	Common output : 4 (Max) Segment output : 32 (Max) LCD driving power (bias) pins : 3 LCD display RAM size : 32 × 4 bits		

(Continued)

# MB89490 Series

(Continued)

Part number Parameter	MB89498	MB89F499	MB89PV490
UART/SIO	Synchronous/asynchronous data transfer capability (Max baud rate : 97.656 Kbps at 12.5 MHz) (7-bit and 8-bit with parity bit; 8-bit and 9-bit without parity bit)		
SIO	8-bit serial I/O with LSB first/MSB first selectability 1 clock selectable from 4 operation clock (1 external shift clock and 3 internal shift clock : 0.64 $\mu$ s, 2.56 $\mu$ s, 10.24 $\mu$ s at 12.5 MHz)		
I <sup>2</sup> C	1 channel (Use a 2-wire protocol to communicate with other device)		
Remote receiver circuit	Selectable maximum noise width removal Reversible input polarity		
Standby mode	Sleep mode, stop mode, watch mode and sub-clock mode		
Process	CMOS		
Operating voltage	2.2 V to 3.6 V	2.7 V to 3.6 V	2.7 V to 3.6 V

\* : Use MBM27C512 as the external ROM.

## ■ PACKAGE AND CORRESPONDING PRODUCTS

Part number Parameter	MB89498	MB89F499	MB89PV490
FPT-100P-M06	○	○	×
FPT-100P-M20	○	○	×
MQP-100C-P01	×	×	○

○ : Available

× : Not available

## ■ DIFFERENCES AMONG PRODUCTS

### 1. Memory Size

Before evaluating using the piggy-back product, verify its differences from the product that will be actually used. Take particular care on the following point : The stack area is set at the upper limit of the RAM.

### 2. Current Consumption

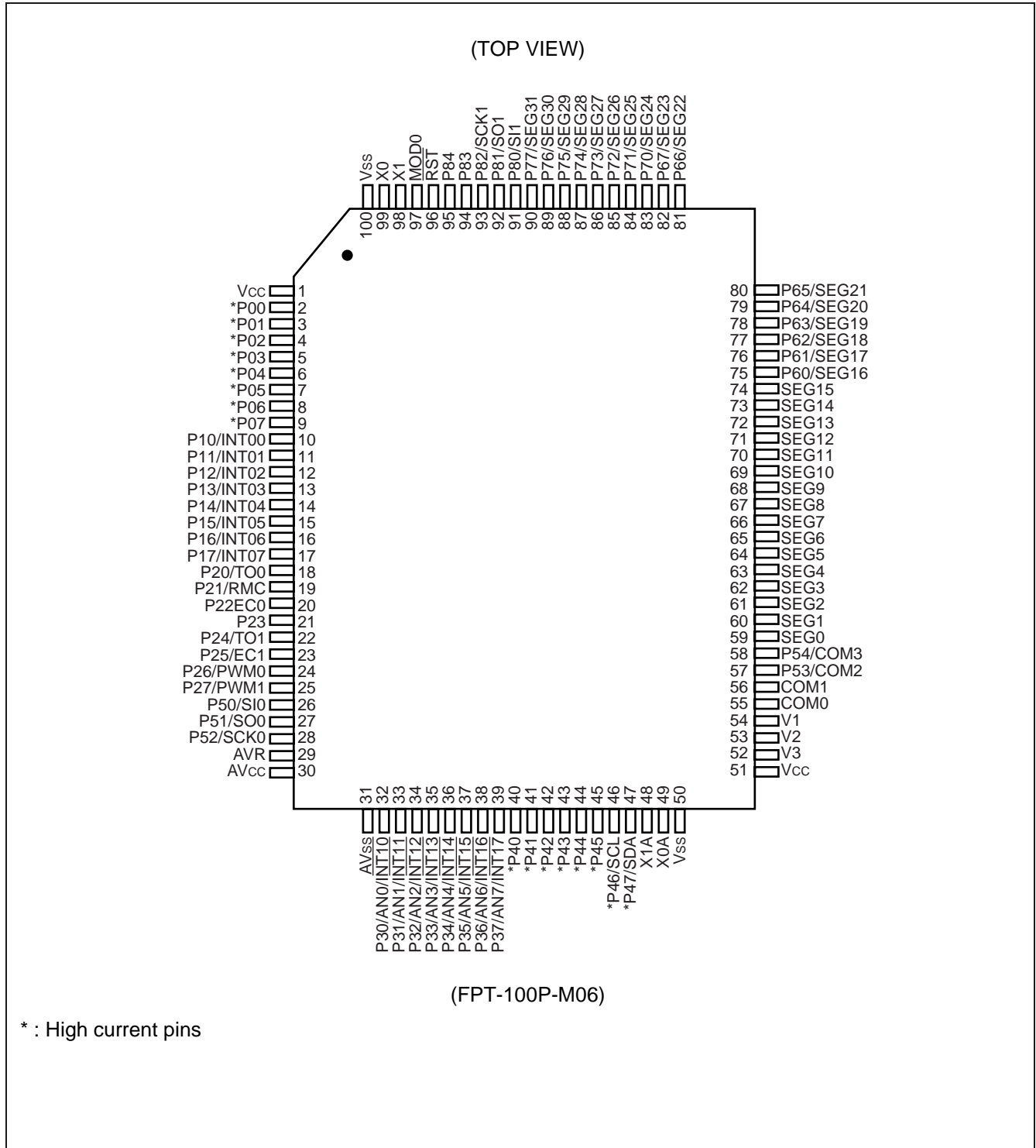
- For the MB89PV490, add the current consumed by the EPROM mounted in the piggy-back socket.
- When operating at low speed, the current consumed by the FLASH product is greater than that for the mask ROM product. However, the current consumption is roughly the same in sleep and stop mode.
- For more information, see “■ ELECTRICAL CHARACTERISTICS”.

### 3. Oscillation Stabilization Wait Time after Power-on Reset

- For MB89PV490 and MB89F499, the power-on stabilization wait time cannot be selected after power-on reset.
- For MB89498, the power-on stabilization wait time can be selected after power-on reset.
- For more information, please refer to “■ MASK OPTIONS”.

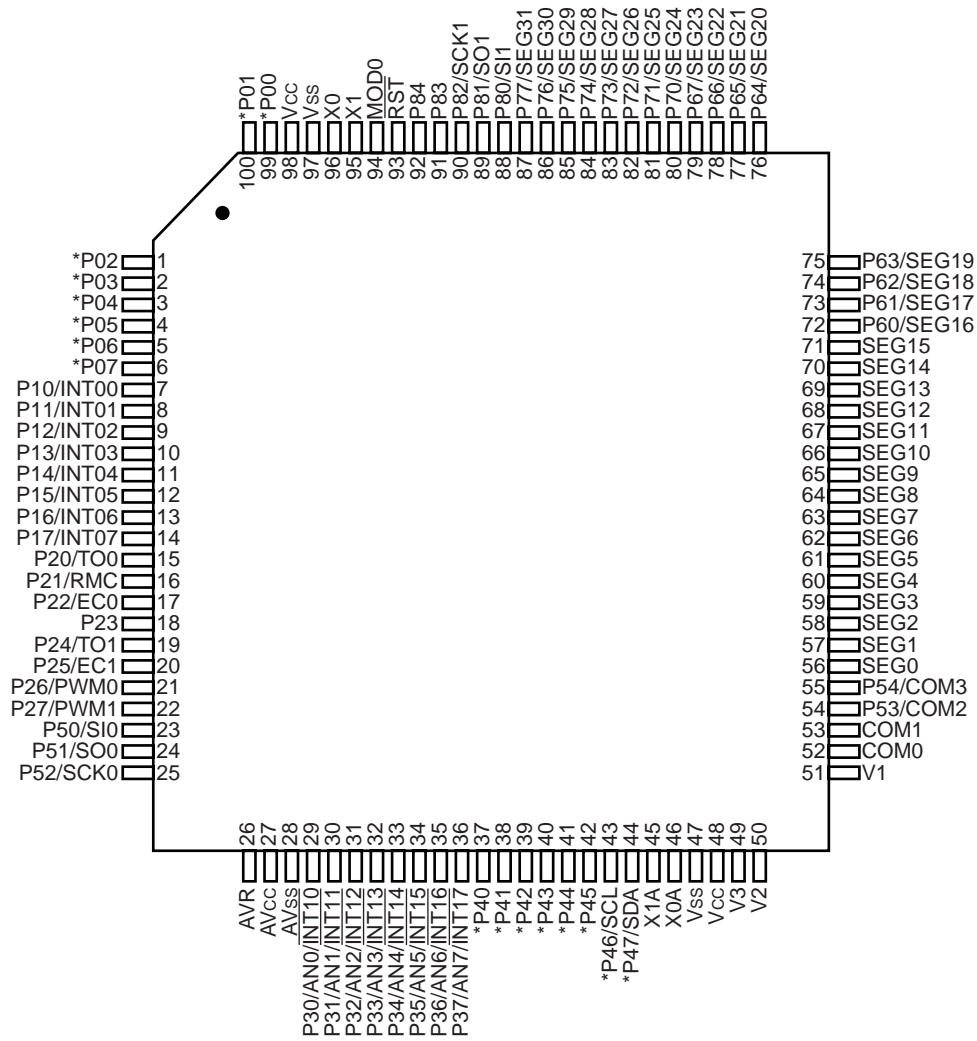
# MB89490 Series

## ■ PIN ASSIGNMENTS



(Continued)

(TOP VIEW)



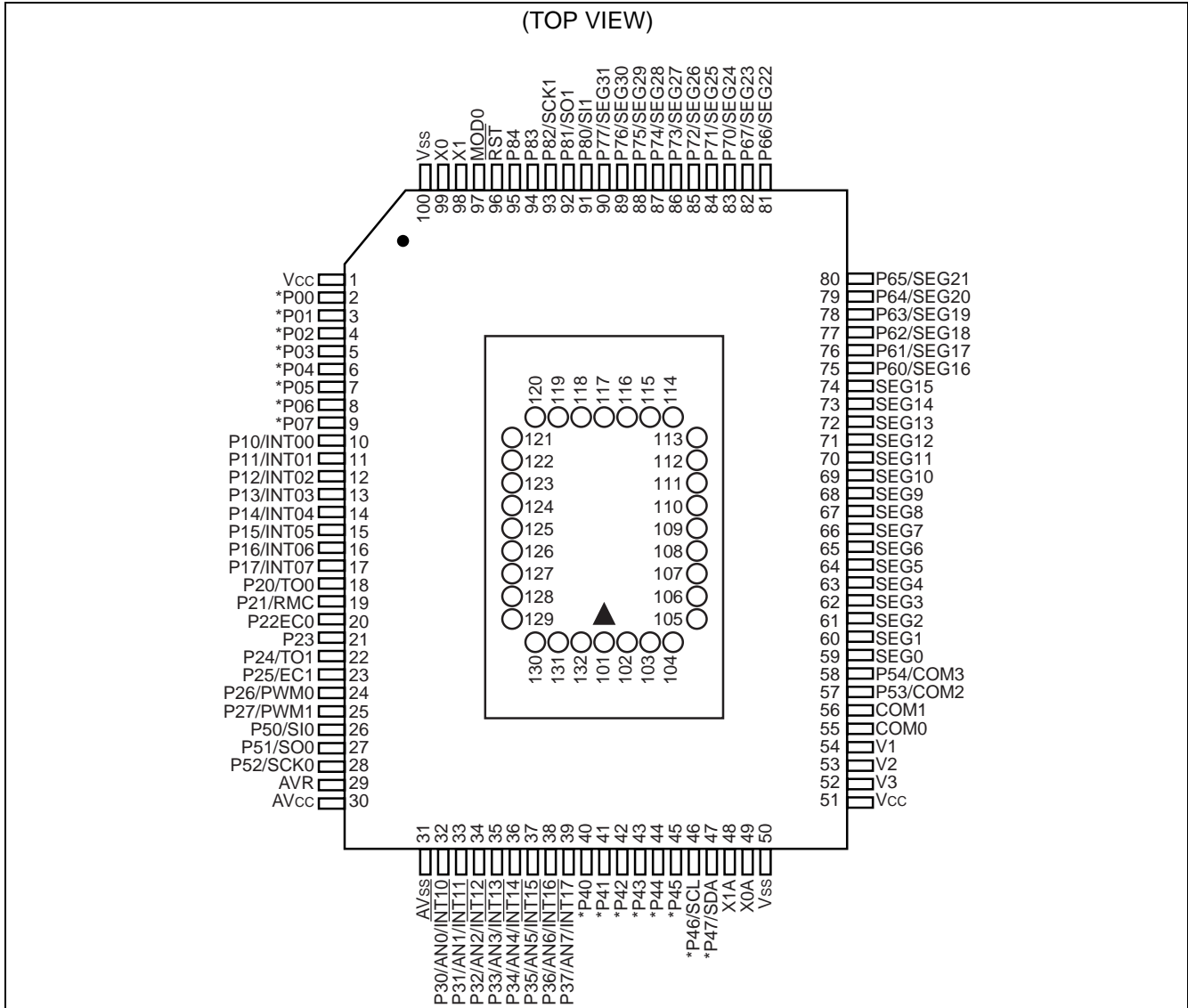
(FPT-100P-M20)

\* : High current pins

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# MB89490 Series

(Continued)



Pin assignment on package top (MB89PV490 only)

Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name
101	N.C.	108	A3	115	O3	122	O8	129	A8
102	A15	109	A2	116	V <sub>ss</sub>	123	$\overline{CE}$	130	A13
103	A12	110	A1	117	N.C.	124	A10	131	A14
104	A7	111	A0	118	O4	125	$\overline{OE}$	132	V <sub>cc</sub>
105	A6	112	N.C.	119	O5	126	N.C.		
106	A5	113	O1	120	O6	127	A11		
107	A4	114	O2	121	O7	128	A9		

N.C. : As connected internally, do not use.



## ■ PIN DESCRIPTION

Pin number		Pin name	I/O circuit type	Function
MQFP*1/ QFP*2	LQFP*3			
99	96	X0	A	Connection pins for a crystal or other oscillator circuit. An external clock can be connected to X0. In this case, leave X1 open.
98	95	X1		
49	46	X0A	A	Connection pins for a crystal or other oscillator circuit. An external clock can be connected to X0A. In this case, leave X1A open.
48	45	X1A		
97	94	MOD0	B	Input pin for setting the memory access mode. Connect directly to V <sub>SS</sub> .
95, 94	92, 91	P84, P83	J	General-purpose CMOS input port.
96	93	$\overline{\text{RST}}$	C	Reset I/O pin. The pin is an N-ch open-drain type with pull-up resistor and hysteresis input. The pin outputs an "L" level when an internal reset request is present. Inputting an "L" level initializes internal circuits.
2 to 9	99 to 6	P00 to P07	D	General-purpose CMOS I/O port.
10 to 17	7 to 14	P10/INT00 to P17/INT07	E	General-purpose CMOS I/O port. The pin is shared with external interrupt 0 input.
18	15	P20/TO0	F	General-purpose CMOS I/O port. The pin is shared with 8/16-bit timer/counter 00 and 01 output.
19	16	P21/RMC	E	General-purpose CMOS I/O port. The pin is shared with remote receiver input.
20	17	P22/EC0	E	General-purpose CMOS I/O port. The pin is shared with 8/16-bit timer/counter 00 and 01 input.
21	18	P23	F	General-purpose CMOS I/O port.
22	19	P24/TO1	F	General-purpose CMOS I/O port. The pin is shared with 8/16-bit timer/counter 10 and 11 output.
23	20	P25/EC1	E	General-purpose CMOS I/O port. The pin is shared with 8/16-bit timer/counter 10 and 11 input.
24	21	P26/PWM0	F	General-purpose CMOS I/O port. The pin is shared with PWM0 output.
25	22	P27/PWM1	F	General-purpose CMOS I/O port. The pin is shared with PWM1 output.
32 to 39	29 to 36	P30/AN0/ $\overline{\text{INT10}}$ to P37/AN7/ $\overline{\text{INT17}}$	G	General-purpose CMOS I/O port. The pin is shared with external interrupt 1 input and A/D converter input.
40 to 45	37 to 42	P40 to P45	H	General-purpose N-ch open-drain I/O port.
46	43	P46/SCL	H	General-purpose N-ch open-drain I/O port. The pin is shared with I <sup>2</sup> C clock I/O.

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# MB89490 Series

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Pin number		Pin name	I/O circuit type	Function
MQFP*1/ QFP*2	LQFP*3			
47	44	P47/SDA	H	General-purpose N-ch open-drain I/O port. The pin is shared with I <sup>2</sup> C data I/O.
26	23	P50/SIO	E	General-purpose CMOS I/O port. The pin is shared with SIO data input.
27	24	P51/SO0	F	General-purpose CMOS I/O port. The pin is shared with SIO data output.
28	25	P52/SCK0	E	General-purpose CMOS I/O port. The pin is shared with SIO clock I/O.
57	54	P53/COM2	F/I	General-purpose CMOS I/O port. The pin is shared with the LCD common output.
58	55	P54/COM3	F/I	General-purpose CMOS I/O port. The pin is shared with the LCD common output.
75 to 82	72 to 79	P60/SEG16 to P67/SEG23	F/I	General-purpose CMOS I/O port. The pin is shared with LCD segment output.
83 to 90	80 to 87	P70/SEG24 to P77/SEG31	F/I	General-purpose CMOS I/O port. The pin is shared with LCD segment output.
91	88	P80/SI1	E	General-purpose CMOS I/O port. The pin is shared with UART/SIO data input.
92	89	P81/SO1	F	General-purpose CMOS I/O port. The pin is shared with UART/SIO data output.
93	90	P82/SCK1	E	General-purpose CMOS I/O port. The pin is shared with UART/SIO clock I/O.
59 to 74	56 to 71	SEG0 to SEG15	I	LCD segment output-only pin.
55, 56	52, 53	COM0, COM1	I	LCD common output-only pin.
54, 53, 52	51, 50, 49	V1 to V3	—	LCD driving power supply pin.
1, 51	98, 48	V <sub>CC</sub>	—	Power supply pin.
50, 100	47, 97	V <sub>SS</sub>	—	Power supply pin (GND) .
30	27	AV <sub>CC</sub>	—	A/D converter power supply pin.
29	26	AVR	—	A/D converter reference voltage input pin.
31	28	AV <sub>SS</sub>	—	A/D converter power supply pin. Use at the same voltage level as V <sub>SS</sub> .

\*1 : MQP-100C-P01

\*2 : FPT-100P-M06

\*3 : FPT-100P-M20

# MB89490 Series

• External EPROM Socket (MB89PV490 only)

Pin number	Pin name	I/O	Function
MQFP*			
102	A15	O	Address output pins.
131	A14		
130	A13		
103	A12		
127	A11		
124	A10		
128	A9		
129	A8		
104	A7		
105	A6		
106	A5		
107	A4		
108	A3		
109	A2		
110	A1	I	Data input pins.
111	A0		
122	O8		
121	O7		
120	O6		
119	O5		
118	O4		
115	O3		
114	O2	—	Internally connected pins. Always leave open.
113	O1		
101	N.C.		
112			
117			
126			
116	V <sub>SS</sub>	O	Power supply pin (GND) .
123	$\overline{CE}$	O	Chip enable pin for the EPROM. Outputs "H" in standby mode.
125	$\overline{OE}$	O	Output enable pin for the EPROM. Always outputs "L".
132	V <sub>CC</sub>	O	Power supply pin for the EPROM.

\* : MQP-100C-P01

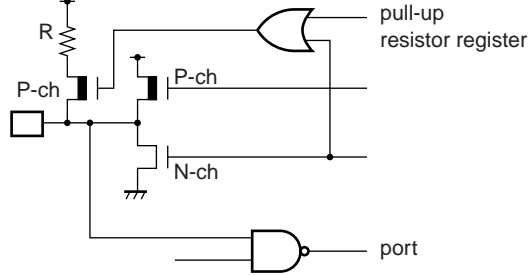
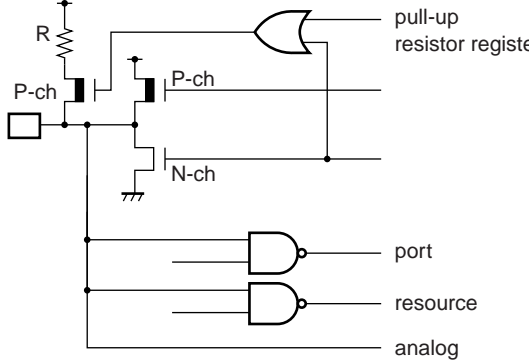
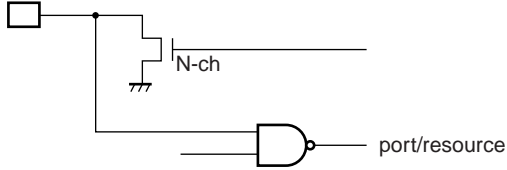
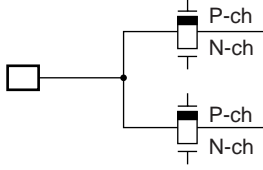
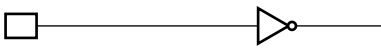
# MB89490 Series

## I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	<p>X1 (X1A) X0 (X0A) N-ch P-ch N-ch P-ch N-ch Stop mode control signal</p>	<ul style="list-style-type: none"> <li>Main/Sub-clock circuit</li> </ul>
B	<p>R</p>	<ul style="list-style-type: none"> <li>Hysteresis input (CMOS input in MB89F499)</li> <li>The pull-down resistor (not available in MB89F499) Approx. 50 k<math>\Omega</math></li> </ul>
C	<p>R P-ch N-ch</p>	<ul style="list-style-type: none"> <li>The pull-up resistor (P-channel) Approx. 50 k<math>\Omega</math></li> <li>Hysteresis input</li> </ul>
D	<p>R P-ch N-ch pull-up resistor register port</p>	<ul style="list-style-type: none"> <li>CMOS output</li> <li><math>I_{OH} = -4 \text{ mA}</math>, <math>I_{OL} = 12 \text{ mA}</math></li> <li>CMOS input</li> <li>Selectable pull-up resistor Approx. 50 k<math>\Omega</math></li> </ul>
E	<p>R P-ch N-ch pull-up resistor register port resource</p>	<ul style="list-style-type: none"> <li>CMOS output</li> <li><math>I_{OH} = -2 \text{ mA}</math>, <math>I_{OL} = 4 \text{ mA}</math></li> <li>CMOS port input</li> <li>Hysteresis resource input</li> <li>Selectable pull-up resistor Approx. 50 k<math>\Omega</math></li> </ul>

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Type	Circuit	Remarks
F		<ul style="list-style-type: none"> <li>• CMOS output</li> <li>• <math>I_{OH} = -2 \text{ mA}</math>, <math>I_{OL} = 4 \text{ mA}</math></li> <li>• CMOS input</li> <li>• Selectable pull-up resistor Approx. <math>50 \text{ k}\Omega</math></li> </ul>
G		<ul style="list-style-type: none"> <li>• CMOS output</li> <li>• <math>I_{OH} = -2 \text{ mA}</math>, <math>I_{OL} = 4 \text{ mA}</math></li> <li>• CMOS port input</li> <li>• <math>V_{IH} = 0.85 V_{CC}</math>, <math>V_{IL} = 0.5 V_{CC}</math> resource input</li> <li>• Analog input</li> <li>• Selectable pull-up resistor Approx. <math>50 \text{ k}\Omega</math></li> </ul>
H		<ul style="list-style-type: none"> <li>• N-ch open-drain output</li> <li>• <math>I_{OL} = 15 \text{ mA}</math></li> <li>• CMOS port input</li> <li>• CMOS resource input</li> <li>• 5 V tolerance</li> </ul>
I		<ul style="list-style-type: none"> <li>• LCD segment output</li> </ul>
J		<ul style="list-style-type: none"> <li>• CMOS input</li> </ul>

## ■ HANDLING DEVICES

### 1. Preventing Latch-up

Latch-up may occur on CMOS IC if voltage higher than  $V_{CC}$  or lower than  $V_{SS}$  is applied to input and output pins other than medium- to high-voltage pins or if higher than the voltage which shows on “1. Absolute Maximum Ratings” in “■ ELECTRICAL CHARACTERISTICS” is applied between  $V_{CC}$  and  $V_{SS}$ .

When latch-up occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the maximum ratings.

Also, take care to prevent the analog power supply ( $AV_{CC}$  and  $AVR$ ) and analog input from exceeding the digital power supply ( $V_{CC}$ ) when the analog system power supply is turned on and off.

### 2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistor.

### 3. Treatment of Power Supply Pins on Microcontrollers with A/D

Connect to be  $AV_{CC} = V_{CC}$  and  $AV_{SS} = AVR = V_{SS}$  even if the A/D is not in use.

### 4. Treatment of N.C. Pins

Be sure to leave (internally connected) N.C. pins open.

### 5. Power Supply Voltage Stabilization

Although  $V_{CC}$  power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. As stabilization guidelines, it is recommended to control voltage fluctuation so that  $V_{CC}$  ripple fluctuations (P-P value) will be less than 10% of the standard  $V_{CC}$  value at the commercial frequency (50 Hz to 60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

### 6. Precautions when Using an External Clock

Even when an external clock is used, oscillation stabilization time is required for power-on reset and wake-up from stop mode.

### 7. Treatment of Unused dedicated LCD pins

When dedicated LCD pins are not in use, keep them open.

## ■ PROGRAMMING AND ERASING FLASH MEMORY ON THE MB89F499

### 1. Flash Memory

The flash memory is located between 1000<sub>H</sub> and FFFF<sub>H</sub> in the CPU memory map and incorporates a flash memory interface circuit that allows read access and program access from the CPU to be performed in the same way as mask ROM. Programming and erasing flash memory is also performed via the flash memory interface circuit by executing instructions in the CPU. This enables the flash memory to be updated in place under the control of the internal CPU, providing an efficient method of updating program and data.

### 2. Flash Memory Features

- 60K bytes × 8-bit configuration (16 K + 8 K + 8 K + 28 K sectors)
- Automatic algorithm (Embedded algorithm : Equivalent to MBM29LV200)
- Includes an erase pause and erase restart function
- Data polling and toggle bit for detection of program/erase completion
- Detection of program/erase completion via CPU interrupt
- Compatible with JEDEC-standard commands
- Sector Protection (sectors can be combined in any combination)
- No. of program/erase cycles : 10,000 (Min)

### 3. Procedure for Programming and Erasing Flash Memory

Programming and reading flash memory cannot be performed at the same time. Accordingly, to program or erase data to the flash memory, the program must first be copied from flash memory to RAM so that programming can be performed without program access from flash memory.

### 4. Flash Memory Register

- Flash memory control status register (FMCS)

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Initial value
007A <sub>H</sub>	INTE	RDYINT	WE	RDY	Reserved	Reserved	—	Reserved	000X00-0 <sub>B</sub>
	R/W	R/W	R/W	R	R/W	R/W	—	R/W	

## 5. Sector Configuration

The table below shows the sector configuration of flash memory and lists the addresses of each sector during CPU access and a flash memory programming.

- Sector configuration of flash memory

Flash Memory	CPU Address	Programmer Address*
16 K bytes	FFFF <sub>H</sub> to C000 <sub>H</sub>	1FFFF <sub>H</sub> to 1C000 <sub>H</sub>
8 K bytes	BFFF <sub>H</sub> to A000 <sub>H</sub>	1BFFF <sub>H</sub> to 1A000 <sub>H</sub>
8 K bytes	9FFF <sub>H</sub> to 8000 <sub>H</sub>	19FFF <sub>H</sub> to 18000 <sub>H</sub>
28 K bytes	7FFF <sub>H</sub> to 1000 <sub>H</sub>	17FFF <sub>H</sub> to 11000 <sub>H</sub>

\* : The programmer address is the address to be used instead of the CPU address when programming data from a parallel flash memory programmer. Use the programmer address on programming or erasing using a general-purpose programmer.



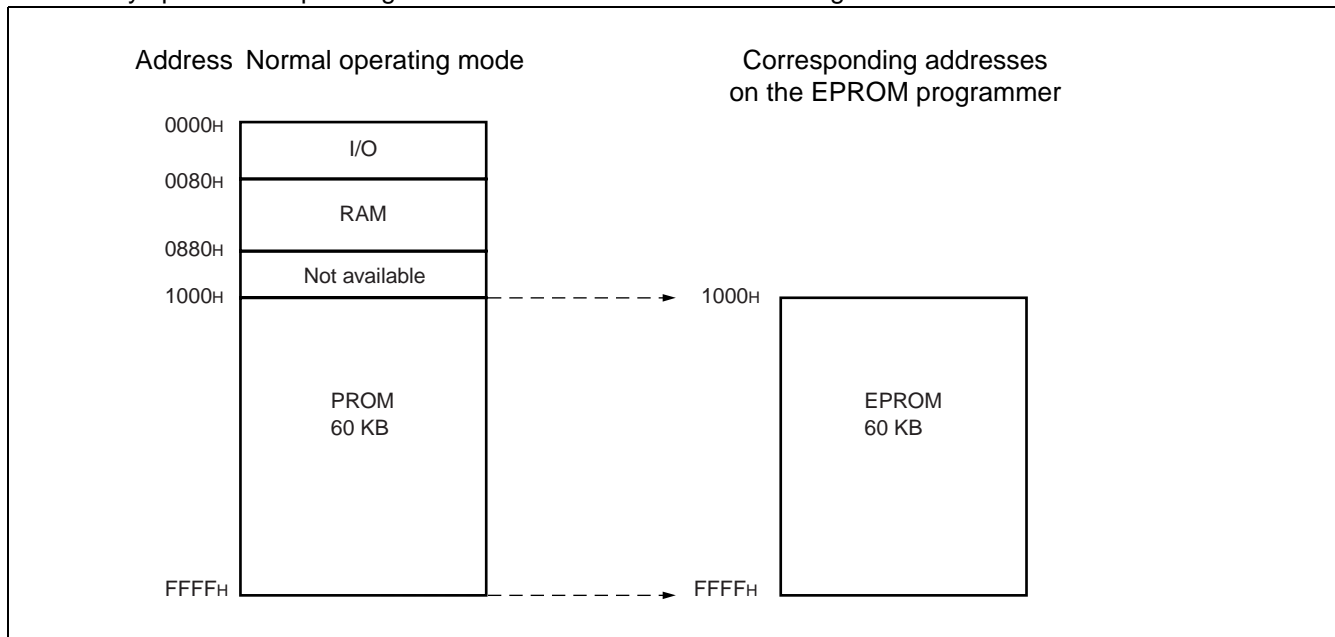
## ■ PROGRAMMING TO THE EPROM WITH PIGGY-BACK/EVALUATION DEVICE

### 1. EPROM for Use

MBM27C512-20TV

### 2. Memory Space

Memory space corresponding to EPROM writer is shown in the diagram below.

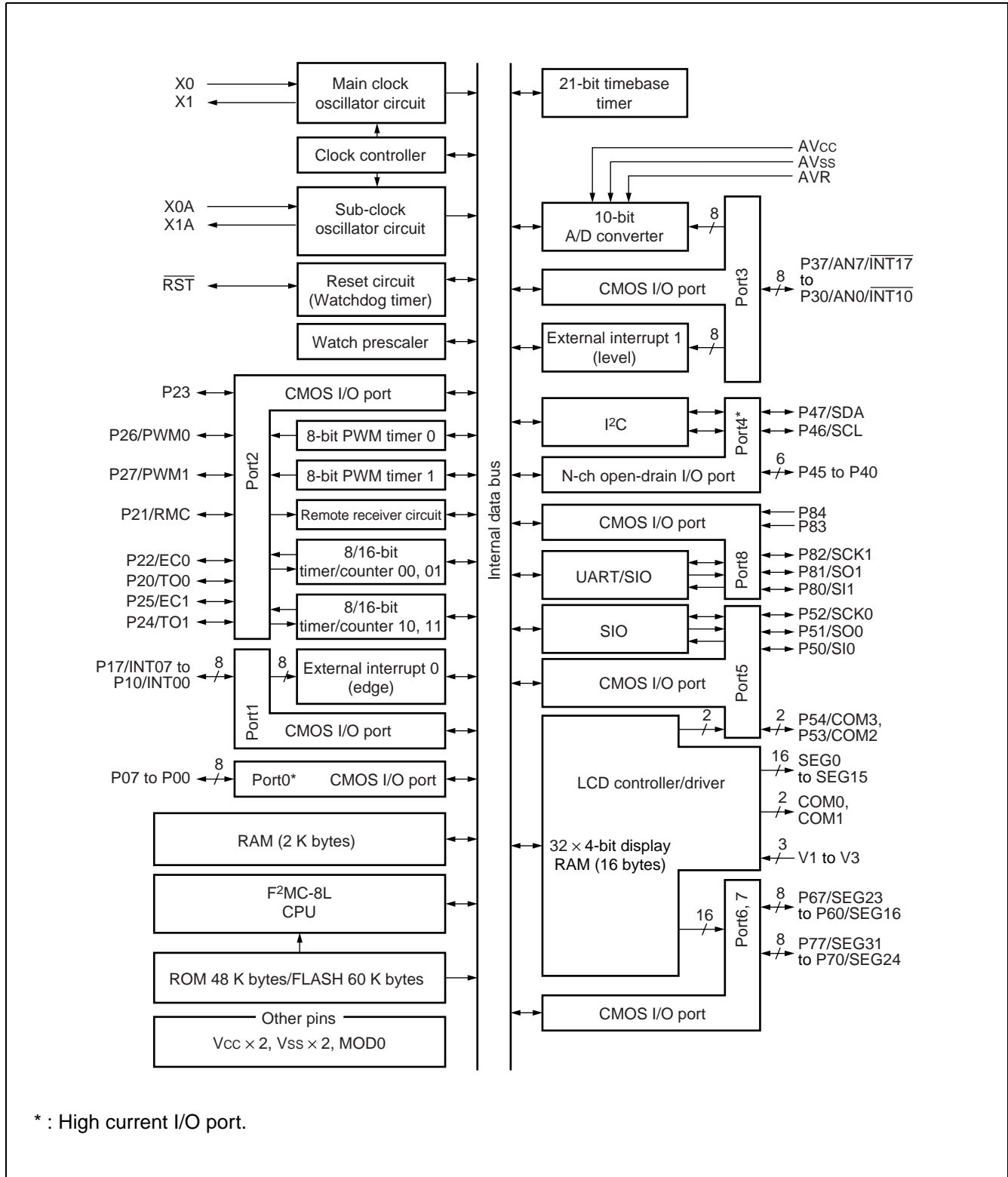


### 3. Programming to the EPROM

- (1) Set the EPROM programmer to the MBM27C512.
- (2) Load program data into the EPROM programmer at 1000H to FFFFH.
- (3) Program to 1000H to FFFFH with the EPROM programmer.

# MB89490 Series

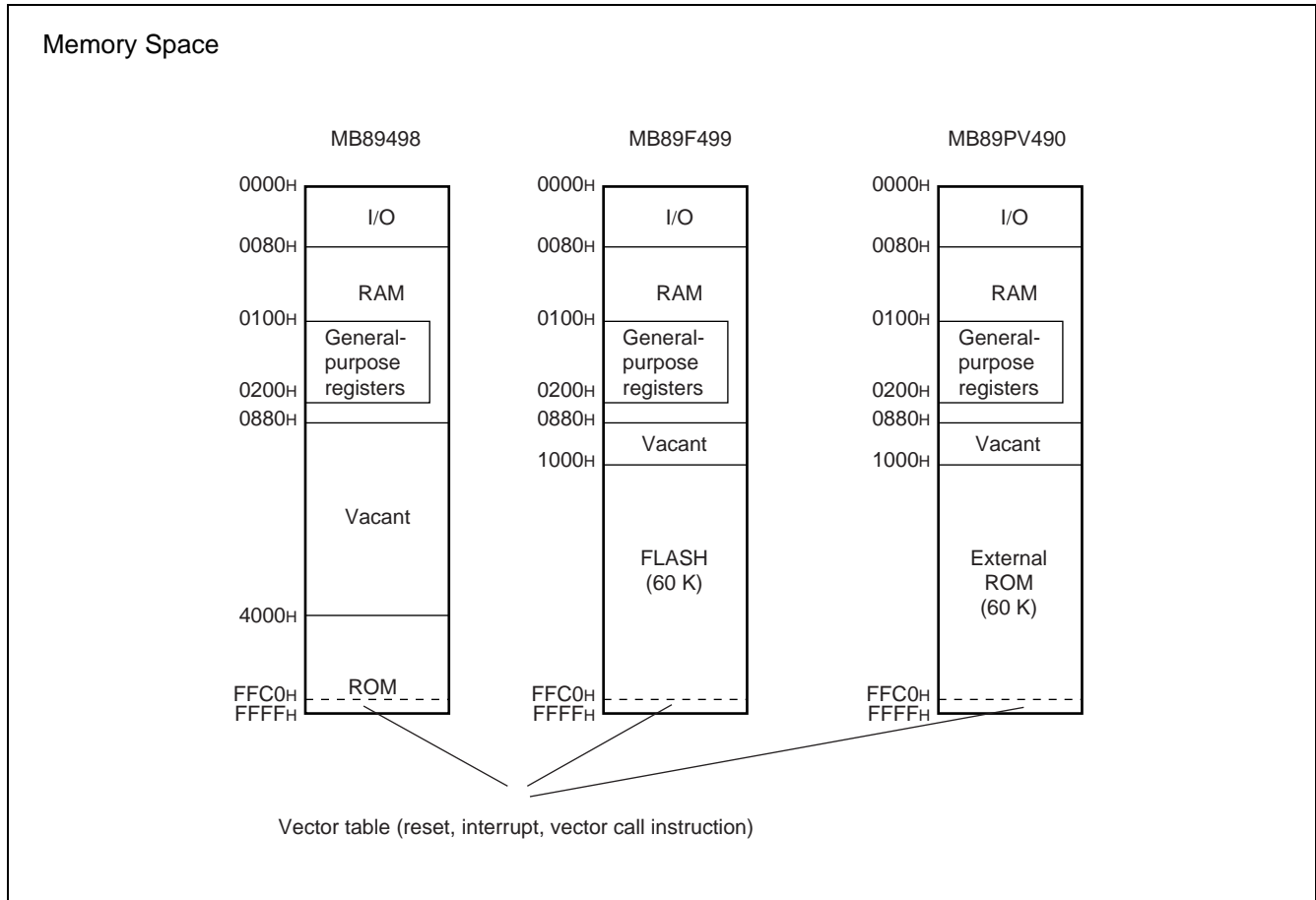
## ■ BLOCK DIAGRAM



## ■ CPU CORE

### 1. Memory Space

The microcontrollers of the MB89490 series offer a memory space of 64K bytes for storing all of I/O, data, and program areas. The I/O area is located the lowest address. The data area is provided immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is located at exactly the opposite end, that is, near the highest address. Provide the tables of interrupt/reset vectors and vector call instructions toward the highest address within the program area. The memory space of the MB89490 series is structured as illustrated below.

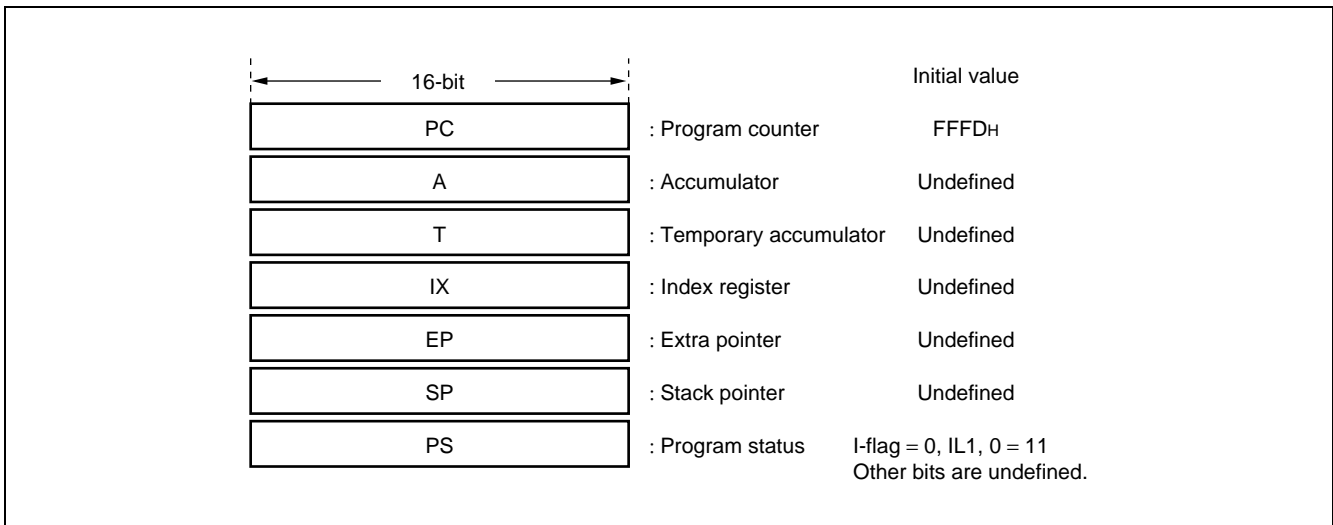


# MB89490 Series

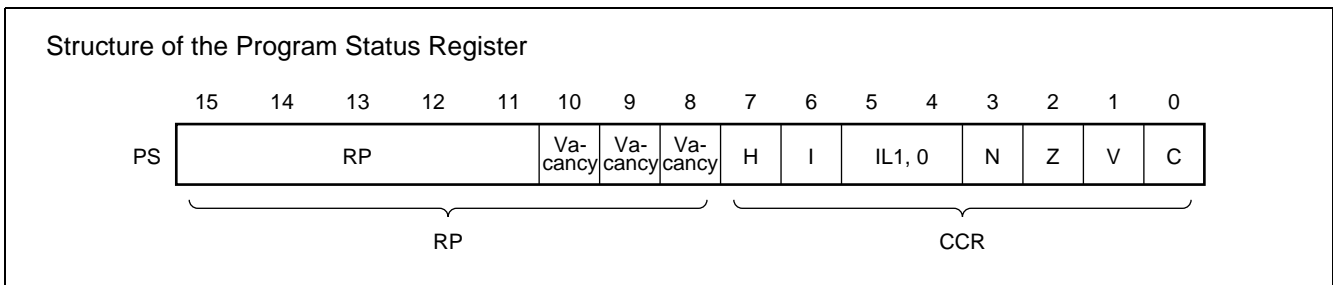
## 2. Registers

The F<sup>2</sup>MC-8L family has 2 types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The following registers are provided :

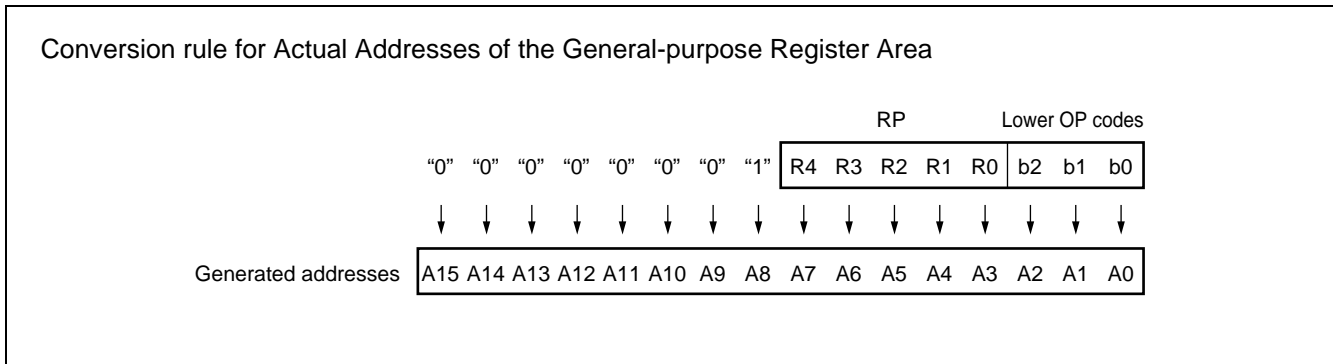
- Program counter (PC) : A 16-bit register for indicating instruction storage positions.
- Accumulator (A) : A 16-bit temporary register for storing arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Temporary accumulator (T) : A 16-bit register for performing arithmetic operations with the accumulator. When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Index register (IX) : A 16-bit register for index modification.
- Extra pointer (EP) : A 16-bit pointer for indicating a memory address.
- Stack pointer (SP) : A 16-bit register for indicating a stack area.
- Program status (PS) : A 16-bit register for storing a register pointer and condition code.



The PS can further be divided into higher 8-bit for use as a register bank pointer (RP) and the lower 8-bit for use as a condition code register (CCR) . (See the diagram below.)



The RP indicates the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule illustrated below.



The CCR consists of bits indicating the results of arithmetic operations and the contents of transfer data and bits for controlling the CPU operations at the time of an interrupt.

H-flag : Set to "1" when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Clear to "0" otherwise. This flag is for decimal adjustment instructions.

I-flag : Interrupt is allowed when this flag is set to "1". Interrupt is prohibited when the flag is set to "0". Clear to "0" at reset.

IL1, 0 : Indicates the level of the interrupt currently allowed. Processes an interrupt only if its request is higher than the value indicated by this bit.

IL1	IL0	Interrupt level	High-low
0	0	1	High ↑ ↓ Low
0	1		
1	0	2	
1	1	3	

N-flag : Set to "1" if the MSB is set to "1" as the result of an arithmetic operation. Clear to "0" otherwise.

Z-flag : Set to "1" when an arithmetic operation results in "0". Clear to "0" otherwise.

V-flag : Set to "1" if the complement on 2 overflows as a result of an arithmetic operation. Clear to "0" if the overflow does not occur.

C-flag : Set to "1" when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Clear to "0" otherwise. Set to the shift-out value in the case of a shift instruction.

# MB89490 Series

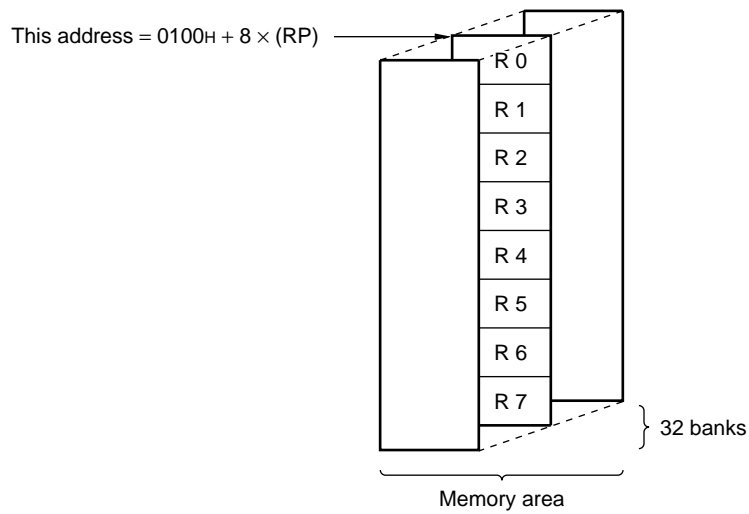
The following general-purpose registers are provided :

General-purpose registers : An 8-bit register for storing data

The general-purpose registers are 8-bit and located in the register banks of the memory.

1 bank contains 8 registers. Up to a total of 32 banks can be used on the MB89490 series. The bank currently in use is indicated by the register bank pointer (RP) .

## Register Bank Configuration



## ■ I/O MAP

Address	Register name	Register description	Read/Write	Initial value
00 <sub>H</sub>	PDR0	Port 0 data register	R/W	XXXXXXXX <sub>B</sub>
01 <sub>H</sub>	DDR0	Port 0 direction register	W*	00000000 <sub>B</sub>
02 <sub>H</sub>	PDR1	Port 1 data register	R/W	XXXXXXXX <sub>B</sub>
03 <sub>H</sub>	DDR1	Port 1 direction register	W*	00000000 <sub>B</sub>
04 <sub>H</sub>	PDR2	Port 2 data register	R/W	00000000 <sub>B</sub>
05 <sub>H</sub>	(Reserved)			
06 <sub>H</sub>	DDR2	Port 2 direction register	R/W	00000000 <sub>B</sub>
07 <sub>H</sub>	SYCC	System clock control register	R/W	X-1MM100 <sub>B</sub>
08 <sub>H</sub>	STBC	Standby control register	R/W	00010XXX <sub>B</sub>
09 <sub>H</sub>	WDTC	Watchdog timer control register	W*	0---XXXX <sub>B</sub>
0A <sub>H</sub>	TBTC	Timebase timer control register	R/W	00---000 <sub>B</sub>
0B <sub>H</sub>	WPCR	Watch prescaler control register	R/W	00--0000 <sub>B</sub>
0C <sub>H</sub>	PDR3	Port 3 data register	R/W	XXXXXXXX <sub>B</sub>
0D <sub>H</sub>	DDR3	Port 3 direction register	R/W	11111111 <sub>B</sub>
0E <sub>H</sub>	RSFR	Reset flag register	R	XXXX---- <sub>B</sub>
0F <sub>H</sub>	PDR4	Port 4 data register	R/W	11111111 <sub>B</sub>
10 <sub>H</sub>	PDR5	Port 5 data register	R/W	---XXXX <sub>B</sub>
11 <sub>H</sub>	DDR5	Port 5 direction register	R/W	---00000 <sub>B</sub>
12 <sub>H</sub>	PDR6	Port 6 data register	R/W	XXXXXXXX <sub>B</sub>
13 <sub>H</sub>	DDR6	Port 6 direction register	R/W	00000000 <sub>B</sub>
14 <sub>H</sub>	PDR7	Port 7 data register	R/W	XXXXXXXX <sub>B</sub>
15 <sub>H</sub>	DDR7	Port 7 direction register	R/W	00000000 <sub>B</sub>
16 <sub>H</sub>	PDR8	Port 8 data register	R/W	---XXXX <sub>B</sub>
17 <sub>H</sub>	DDR8	Port 8 direction register	R/W	---00000 <sub>B</sub>
18 <sub>H</sub>	EIC0	External interrupt 0 control register 0	R/W	00000000 <sub>B</sub>
19 <sub>H</sub>	EIC1	External interrupt 0 control register 1	R/W	00000000 <sub>B</sub>
1A <sub>H</sub>	EIC2	External interrupt 0 control register 2	R/W	00000000 <sub>B</sub>
1B <sub>H</sub>	EIC3	External interrupt 0 control register 3	R/W	00000000 <sub>B</sub>
1C <sub>H</sub>	EIE1	External interrupt 1 enable register	R/W	00000000 <sub>B</sub>
1D <sub>H</sub>	EIF1	External interrupt 1 flag register	R/W	-----0 <sub>B</sub>
1E <sub>H</sub>	SMR	Serial mode register	R/W	00000000 <sub>B</sub>
1F <sub>H</sub>	SDR	Serial data register	R/W	XXXXXXXX <sub>B</sub>
20 <sub>H</sub>	T01CR	Timer 01 control register	R/W	000000X0 <sub>B</sub>
21 <sub>H</sub>	T00CR	Timer 00 control register	R/W	000000X0 <sub>B</sub>
22 <sub>H</sub>	T01DR	Timer 01 data register	R/W	XXXXXXXX <sub>B</sub>

(Continued)

# MB89490 Series

Address	Register name	Register description	Read/Write	Initial value
23 <sub>H</sub>	T00DR	Timer 00 data register	R/W	XXXXXXXX <sub>B</sub>
24 <sub>H</sub>	T11CR	Timer 11 control register	R/W	000000X0 <sub>B</sub>
25 <sub>H</sub>	T10CR	Timer 10 control register	R/W	000000X0 <sub>B</sub>
26 <sub>H</sub>	T11DR	Timer 11 data register	R/W	XXXXXXXX <sub>B</sub>
27 <sub>H</sub>	T10DR	Timer 10 data register	R/W	XXXXXXXX <sub>B</sub>
28 <sub>H</sub>	ADER	A/D input enable register	R/W	11111111 <sub>B</sub>
29 <sub>H</sub>	ADC0	A/D control register 0	R/W	-00000X0 <sub>B</sub>
2A <sub>H</sub>	ADC1	A/D control register 1	R/W	-0000001 <sub>B</sub>
2B <sub>H</sub>	ADDH	A/D data register (Upper byte)	R	-----XX <sub>B</sub>
2C <sub>H</sub>	ADDL	A/D data register (Lower byte)	R	XXXXXXXX <sub>B</sub>
2D <sub>H</sub>	CNTR0	PWM 0 timer control register	R/W	0-000000 <sub>B</sub>
2E <sub>H</sub>	COMR0	PWM 0 timer compare register	W*	XXXXXXXX <sub>B</sub>
2F <sub>H</sub>	SMC0	UART/SIO serial mode control register	R/W	00000000 <sub>B</sub>
30 <sub>H</sub>	SMC1	UART/SIO serial mode control register	R/W	00000000 <sub>B</sub>
31 <sub>H</sub>	SSD	UART/SIO serial status/data register	R/W	00001--- <sub>B</sub>
32 <sub>H</sub>	SIDR/SODR	UART/SIO serial data register	R/W	XXXXXXXX <sub>B</sub>
33 <sub>H</sub>	SRC	UART/SIO serial rate control register	R/W	XXXXXXXX <sub>B</sub>
34 <sub>H</sub>	CNTR1	PWM 1 timer control register	R/W	0-000000 <sub>B</sub>
35 <sub>H</sub>	COMR1	PWM 1 timer compare register	W*	XXXXXXXX <sub>B</sub>
36 <sub>H</sub>	IBSR	I <sup>2</sup> C bus status register	R	00000000 <sub>B</sub>
37 <sub>H</sub>	IBCR	I <sup>2</sup> C bus control register	R/W	00000000 <sub>B</sub>
38 <sub>H</sub>	ICCR	I <sup>2</sup> C clock control register	R/W	000XXXXX <sub>B</sub>
39 <sub>H</sub>	IADR	I <sup>2</sup> C address register	R/W	-XXXXXXXX <sub>B</sub>
3A <sub>H</sub>	IDAR	I <sup>2</sup> C data register	R/W	XXXXXXXX <sub>B</sub>
3B <sub>H</sub>	PLLCR	Sub PLL control register	R/W	----0000 <sub>B</sub>
3C <sub>H</sub> to 3F <sub>H</sub>	(Reserved)			
40 <sub>H</sub>	RMN	Remote control counter register	R	XXXXXXXX <sub>B</sub>
41 <sub>H</sub>	RMC	Remote control control register	R/W	00000000 <sub>B</sub>
42 <sub>H</sub>	RMS	Remote control status register	R/W	0X000001 <sub>B</sub>
43 <sub>H</sub>	RMD	Remote control FIFO data register	R	X---XXX <sub>B</sub>
44 <sub>H</sub>	RMCD0	Remote control compare register 0	R/W	11111111 <sub>B</sub>
45 <sub>H</sub>	RMCD1	Remote control compare register 1	R/W	11111111 <sub>B</sub>
46 <sub>H</sub>	RMCD2	Remote control compare register 2	R/W	11111111 <sub>B</sub>
47 <sub>H</sub>	RMCD3	Remote control compare register 3	R/W	11111111 <sub>B</sub>
48 <sub>H</sub>	RMCD4	Remote control compare register 4	R/W	11111111 <sub>B</sub>

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Address	Register name	Register description	Read/Write	Initial value
49 <sub>H</sub>	RMCD5	Remote control compare register 5	R/W	11111111 <sub>B</sub>
4A <sub>H</sub>	RMCI	Remote interrupt register	R/W	0000-000 <sub>B</sub>
4B <sub>H</sub> to 5D <sub>H</sub>	(Reserved)			
5E <sub>H</sub>	LOCR	LCD controller output control register	R/W	-0000000 <sub>B</sub>
5F <sub>H</sub>	LCR	LCD controller control register	R/W	00010000 <sub>B</sub>
60 <sub>H</sub> to 6F <sub>H</sub>	VRAM	LCD data RAM	R/W	XXXXXXXX <sub>B</sub>
70 <sub>H</sub>	PUCR0	Port 0 pull up resistor control register	R/W	11111111 <sub>B</sub>
71 <sub>H</sub>	PUCR1	Port 1 pull up resistor control register	R/W	11111111 <sub>B</sub>
72 <sub>H</sub>	PUCR2	Port 2 pull up resistor control register	R/W	11111111 <sub>B</sub>
73 <sub>H</sub>	PUCR3	Port 3 pull up resistor control register	R/W	11111111 <sub>B</sub>
74 <sub>H</sub>	PUCR5	Port 5 pull up resistor control register	R/W	---11111 <sub>B</sub>
75 <sub>H</sub>	PUCR6	Port 6 pull up resistor control register	R/W	11111111 <sub>B</sub>
76 <sub>H</sub>	PUCR7	Port 7 pull up resistor control register	R/W	11111111 <sub>B</sub>
77 <sub>H</sub>	PUCR8	Port 8 pull up resistor control register	R/W	-----111 <sub>B</sub>
78 <sub>H</sub> to 79 <sub>H</sub>	(Reserved)			
7A <sub>H</sub>	FMCS	Flash memory control status register	R/W	000X00-0 <sub>B</sub>
7B <sub>H</sub>	ILR1	Interrupt level setting register 1	W*	11111111 <sub>B</sub>
7C <sub>H</sub>	ILR2	Interrupt level setting register 2	W*	11111111 <sub>B</sub>
7D <sub>H</sub>	ILR3	Interrupt level setting register 3	W*	11111111 <sub>B</sub>
7E <sub>H</sub>	ILR4	Interrupt level setting register 4	W*	11111111 <sub>B</sub>
7F <sub>H</sub>	(Reserved)			

\* : Bit manipulation instruction cannot be used.

- **Read/write access symbols**

R/W: Readable and writable

R : Read-only

W : Write-only

- **Initial value symbols**

0 : The initial value of this bit is "0".

1 : The initial value of this bit is "1".

X : The initial value of this bit is undefined.

- : Unused bit.

M : The initial value of this bit is determined by mask option.

# MB89490 Series

## ■ ELECTRICAL CHARACTERISTICS

### 1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V <sub>CC</sub> AV <sub>CC</sub>	V <sub>SS</sub> - 0.3	V <sub>SS</sub> + 4.0	V	AV <sub>CC</sub> must be equal to V <sub>CC</sub>
	AVR	V <sub>SS</sub> - 0.3	V <sub>SS</sub> + 4.0	V	
LCD power supply voltage	V1 to V3	V <sub>SS</sub> - 0.3	V <sub>CC</sub>	V	
Input voltage *1	V <sub>I</sub>	V <sub>SS</sub> - 0.3	V <sub>CC</sub> + 0.3	V	Except P40 to P47
		V <sub>SS</sub> - 0.3	V <sub>SS</sub> + 6.0	V	P40 to P47 in MB89PV490 and MB89498
		V <sub>SS</sub> - 0.3	V <sub>SS</sub> + 5.5	V	P40 to P47 in MB89F499
Output voltage*1	V <sub>O</sub>	V <sub>SS</sub> - 0.3	V <sub>CC</sub> + 0.3	V	
Maximum clamp current	I <sub>CLAMP</sub>	- 2.0	+ 2.0	mA	*2
Total maximum clamp current	∑ I <sub>CLAMP</sub>	—	20	mA	*2
“L” level maximum output current	I <sub>OL</sub>	—	15	mA	
“L” level average output current	I <sub>OLAV</sub>	—	4	mA	Average value (operating current × operating rate)
“L” level total maximum output current	∑I <sub>OL</sub>	—	100	mA	
“L” level total average output current	∑I <sub>OLAV</sub>	—	40	mA	Average value (operating current × operating rate)
“H” level maximum output current	I <sub>OH</sub>	—	- 15	mA	
“H” level average output current	I <sub>OHAV</sub>	—	- 4	mA	Average value (operating current × operating rate)
“H” level total maximum output current	∑I <sub>OH</sub>	—	- 50	mA	
“H” level total average output current	∑I <sub>OHAV</sub>	—	- 20	mA	Average value (operating current × operating rate)
Power consumption	P <sub>D</sub>	—	300	mW	
Operating temperature	T <sub>A</sub>	- 40	+ 85	°C	
Storage temperature	T <sub>stg</sub>	- 55	+ 150	°C	

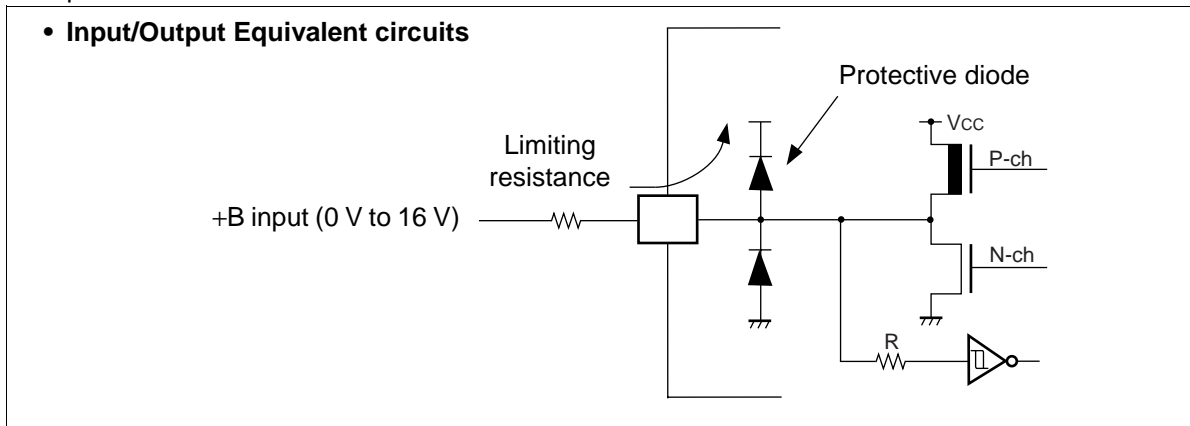
\*1 : The parameter is based on AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V.

- \*2 : • Applicable to pins : P00 to P07, P10 to P17, P20 to P27, P30 to P37, P50 to P52, P80 to P82  
 • Use within recommended operating conditions.  
 • Use at DC voltage (current) .  
 • The +B signal should always be applied with a limiting resistance placed between the +B signal and the microcontroller.  
 • The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.

(Continued)

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- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the  $V_{CC}$  pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller current is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on result.
- Care must be taken not to leave the +B input pin open.
- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
- Sample recommended circuits :



**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

# MB89490 Series

## 2. Recommended Operating Conditions

(AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V)

Parameter	Symbol	Value		Unit	Remarks	
		Min	Max			
Power supply voltage	V <sub>CC</sub> AV <sub>CC</sub>	2.7*	3.6	V	Normal operation assurance range	MB89PV490 and MB89F499
		2.2*	3.6	V	Normal operation assurance range	MB89498
		1.5	3.6	V	Retains the RAM state in stop mode	
	AVR	2.7	3.6	V		
LCD power supply voltage	V1 to V3	V <sub>SS</sub>	V <sub>CC</sub>	V		
Operating temperature	T <sub>A</sub>	-40	+85	°C		

\* : These values depend on the operating conditions and the analog assurance range. See Figure 1, 2 and "5. A/D Converter Electrical Characteristics".

**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

Figure1 Operating Voltage vs. Main Clock Operating Frequency (MB89F499/498)

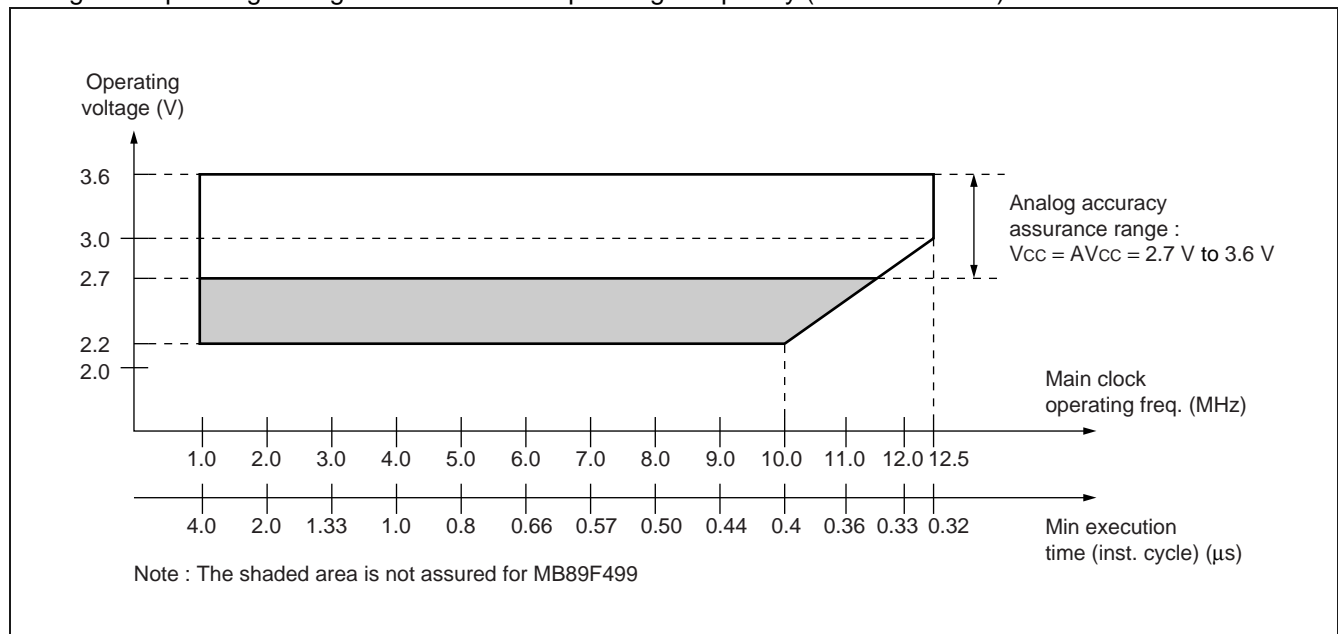


Figure2 Operating Voltage vs. Main Clock Operating Frequency (MB89PV490)

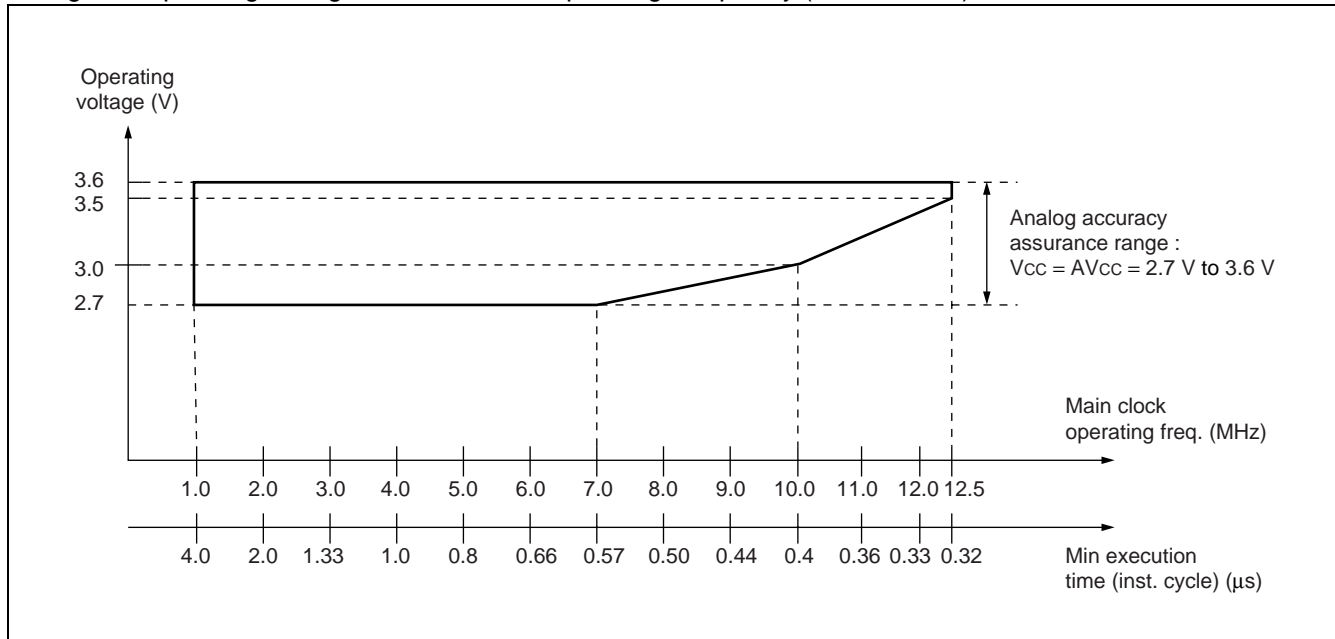


Figure 1 and 2 indicate the operating frequency of the external oscillator at an instruction cycle of  $4/F_{CH}$ .

Since the operating voltage range is dependent on the instruction cycle, see figure 1 and 2 if the operating speed is switched using a gear.

# MB89490 Series

## 3. DC Characteristics

( $A_{V_{CC}} = V_{CC} = 3.0\text{ V}$ ,  $A_{V_{SS}} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	$V_{IH}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P50 to P54, P60 to P67, P70 to P77, P80 to P84, SCL, SDA,	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	
		P40 to P47	—	$0.7 V_{CC}$	—	$V_{SS} + 6.0$	V	MB89498
			—	$0.7 V_{CC}$	—	$V_{SS} + 5.5$	V	MB89F499
	$V_{IHS}$	$\overline{RST}$ , MOD0, EC0, EC1, SCK0, SI0, SCK1, SI1, RMC, INT00 to INT07	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	
	$V_{IHA}$	$\overline{INT10}$ to $\overline{INT17}$	—	$0.85 V_{CC}$	—	$V_{CC} + 0.3$	V	
"L" level input voltage	$V_{IL}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P54, P60 to P67, P70 to P77, P80 to P84, SCL, SDA,	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	
		$\overline{RST}$ , MOD0, EC0, EC1, SCK0, SI0, SCK1, SI1, RMC, INT00 to INT07	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	
	$V_{ILA}$	$\overline{INT10}$ to $\overline{INT17}$	—	$V_{SS} - 0.3$	—	$0.5 V_{CC}$	V	
Open-drain output pin application voltage	$V_D$	P40 to P47	—	$V_{SS} - 0.3$	—	$V_{SS} + 6.0$	V	MB89498
			—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	MB89F499

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# MB89490 Series

( $AV_{CC} = V_{CC} = 3.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
“H” level output voltage	$V_{OH}$	P10 to P17, P20 to P27, P30 to P37, P50 to P54, P60 to P67, P70 to P77, P80 to P82	$I_{OH} = -2.0\text{ mA}$	2.2	—	—	V	
		P00 to P07	$I_{OH} = -4.0\text{ mA}$	2.2	—	—	V	
“L” level output voltage	$V_{OL}$	P10 to P17, P20 to P27, P30 to P37, P50 to P54, P60 to P67, P70 to P77, P80 to P82, $\overline{RST}$	$I_{OL} = 4.0\text{ mA}$	—	—	0.4	V	
		P00 to P07	$I_{OL} = 12.0\text{ mA}$	—	—	0.4	V	
		P40 to P47	$I_{OL} = 15.0\text{ mA}$	—	—	0.4	V	
Input leakage current	$I_{LI}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P54, P60 to P67, P70 to P77, P80 to P84	$0.45\text{ V} < V_I < V_{CC}$	-5	—	+5	$\mu\text{A}$	Without pull-up resistor
Open-drain output leakage current	$I_{LOD}$	P40 to P47	$0.0\text{ V} < V_I < V_{CC}$	-5	—	+5	$\mu\text{A}$	
Pull-down resistance	$R_{DOWN}$	MOD0	$V_I = V_{CC}$	25	50	100	k $\Omega$	Except MB89F499
Pull-up resistance	$R_{PULL}$	P00 to P07, P10 to P17, P20 to P27, P30 to P37, P50 to P54, P60 to P67, P70 to P77, P80 to P82, $\overline{RST}$	$V_I = 0.0\text{ V}$	25	50	100	k $\Omega$	When pull-up resistor is selected (except $\overline{RST}$ )
Common output impedance	$R_{VCOM}$	COM0 to COM3	$V_1$ to $V_3 = +3.0\text{ V}$	—	—	2.5	k $\Omega$	

(Continued)

# MB89490 Series

( $AV_{CC} = V_{CC} = 3.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Segment output impedance	$R_{VSEG}$	SEG0 to SEG31	$V1$ to $V3 = +3.0\text{ V}$	—	—	15	$k\Omega$	
LCD divided resistance	$R_{LCD}$	—	Between $V_{CC}$ and $V_{SS}$	300	500	750	$k\Omega$	
LCD controller/driver leakage current	$I_{LCDL}$	$V1$ to $V3$ , COM0 to COM3, SEG0 to SEG31	—	-1	—	+1	$\mu\text{A}$	
Power supply current	$I_{CC1}$	$V_{CC}$	$F_{CH} = 12.5\text{ MHz}$ $t_{inst} = 0.33\text{ }\mu\text{s}$ Main clock run mode	—	8.0	12	$\text{mA}$	MB89F499
				—	7.0	12.0	$\text{mA}$	MB89498
	$I_{CC2}$		$F_{CH} = 12.5\text{ MHz}$ $t_{inst} = 5.33\text{ }\mu\text{s}$ Main clock run mode	—	1.0	3.0	$\text{mA}$	MB89F499 MB89498
	$I_{CCS1}$		$F_{CH} = 12.5\text{ MHz}$ $t_{inst} = 0.33\text{ }\mu\text{s}$ Main clock sleep mode	—	3.0	5.0	$\text{mA}$	MB89F499 MB89498
	$I_{CCS2}$		$F_{CH} = 12.5\text{ MHz}$ $t_{inst} = 5.33\text{ }\mu\text{s}$ Main clock sleep mode	—	0.6	2.0	$\text{mA}$	MB89F499 MB89498
	$I_{CCL}$		$F_{CL} = 32.768\text{ kHz}$ Sub-clock mode $T_A = +25\text{ }^\circ\text{C}$	—	40.0	60.0	$\mu\text{A}$	MB89F499 MB89498
	$I_{CCLPLL}$		$F_{CL} = 32.768\text{ kHz}$ Sub-clock mode $T_A = +25\text{ }^\circ\text{C}$ sub PLL $\times 4$	—	180.0	250.0	$\mu\text{A}$	MB89F499 MB89498
	$I_{CCLS}$		$F_{CL} = 32.768\text{ kHz}$ Sub-clock sleep mode $T_A = +25\text{ }^\circ\text{C}$	—	14.0	30.0	$\mu\text{A}$	MB89F499 MB89498
$I_{CCT}$	$F_{CL} = 32.768\text{ kHz}$ Watch mode Main clock stop mode $T_A = +25\text{ }^\circ\text{C}$	—	1.5	13.0	$\mu\text{A}$	MB89F499 MB89498		

(Continued)



# MB89490 Series

(Continued)

(AV<sub>CC</sub> = V<sub>CC</sub> = 3.0 V, AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = -40 °C to +85 °C)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current	I <sub>CCH</sub>	V <sub>CC</sub>	T <sub>A</sub> = +25 °C Sub-clock stop mode	—	0.8	4.0	μA	MB89F499 MB89498
	I <sub>A</sub>	AV <sub>CC</sub>	AV <sub>CC</sub> = 3.0 V, T <sub>A</sub> = +25 °C	—	1.2	4.4	mA	A/D converting
	I <sub>AH</sub>		T <sub>A</sub> = +25 °C	—	0.8	4.0	μA	A/D stop
Input capacitance	C <sub>IN</sub>	Except V <sub>CC</sub> , V <sub>SS</sub> , AV <sub>CC</sub> , AV <sub>SS</sub> , AVR	f = 1 MHz	—	10.0	—	pF	

## 4. AC Characteristics

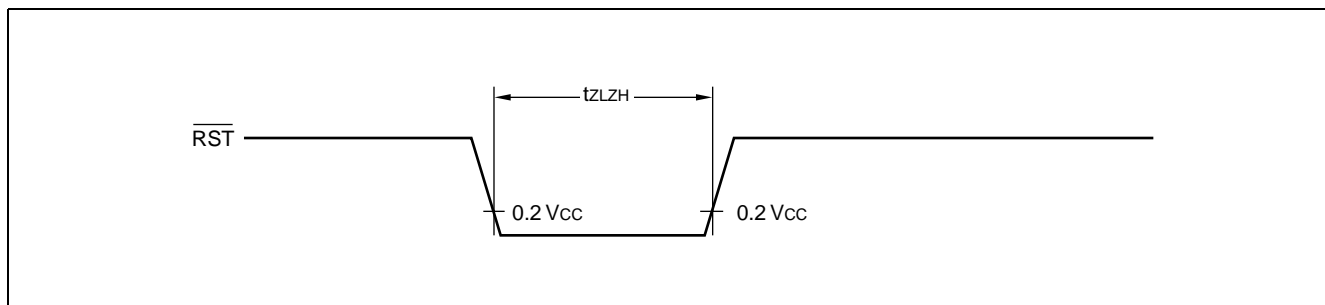
### (1) Reset Timing

( $AV_{CC} = V_{CC} = 3.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
$\overline{\text{RST}}$ "L" pulse width	$t_{\text{ZLZH}}$	—	48 $t_{\text{HCYL}}$	—	ns	

Note :  $t_{\text{HCYL}}$  is the oscillation cycle ( $1/F_{\text{CH}}$ ) to input to the X0 pin.

The MCU operation is not guaranteed when the "L" pulse width is shorter than  $t_{\text{ZLZH}}$ .



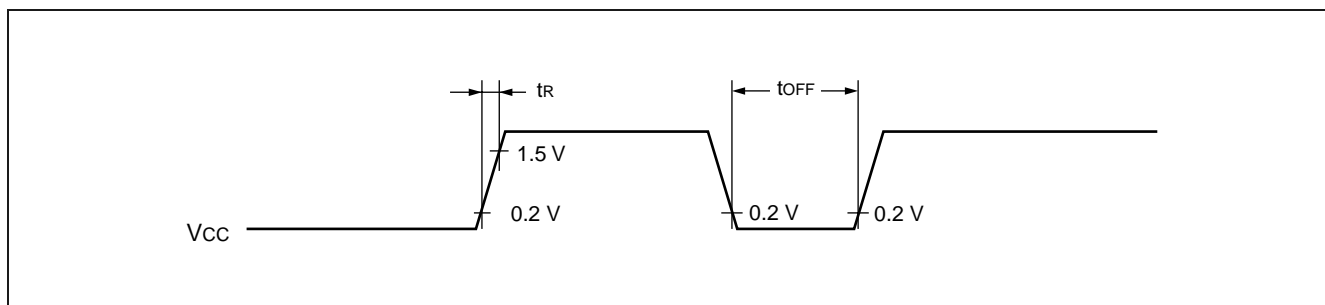
### (2) Power-on Reset

( $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	$t_{\text{R}}$	—	—	50	ms	
Power supply cut-off time	$t_{\text{OFF}}$	—	1	—	ms	Due to repeated operations

Note : Make sure that power supply rises within the selected oscillation stabilization time.

Rapid changes in power supply voltage may cause a power-on reset. If power supply voltage needs to be varied in the course of operation, a smooth voltage rise is recommended.

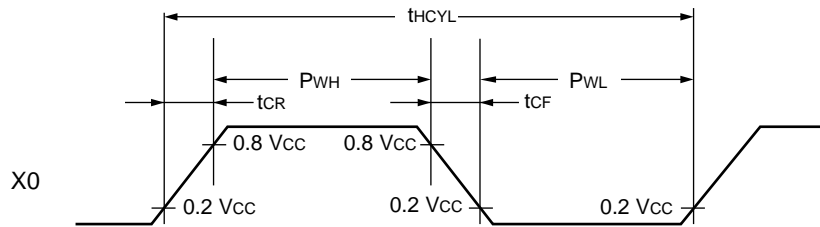


## (3) Clock Timing

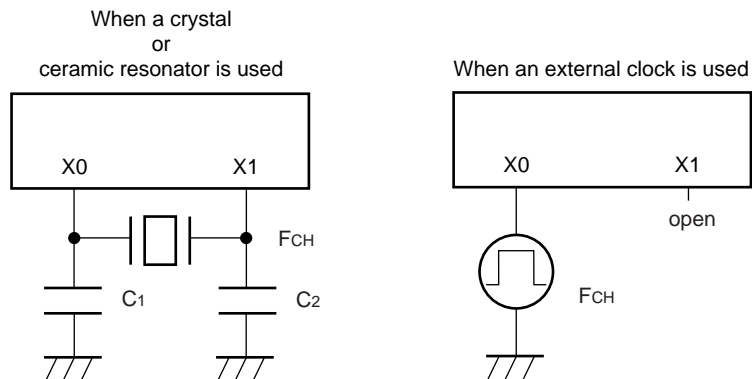
( $V_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	$F_{CH}$	X0, X1	1	—	12.5	MHz	
	$F_{CL}$	X0A, X1A	—	32.768	75	kHz	
Clock cycle time	$t_{HCYL}$	X0, X1	80	—	1000	ns	
	$t_{LCYL}$	X0A, X1A	13.3	30.5	—	$\mu\text{s}$	
Input clock pulse width	$P_{WH}$ $P_{WL}$	X0	20	—	—	ns	External clock
	$P_{WHL}$ $P_{WLL}$	X0A	—	15.2	—	$\mu\text{s}$	
Input clock rising/falling time	$t_{CR}$ $t_{CF}$	X0, X0A	—	—	10	ns	

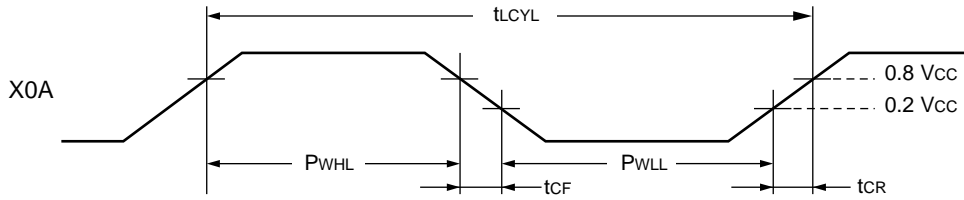
### X0 and X1 Timing and Conditions



### Main Clock Conditions

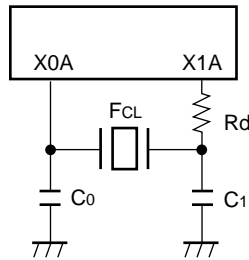


## Sub-clock Timing and Conditions

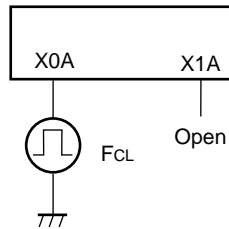


## Sub-clock Conditions

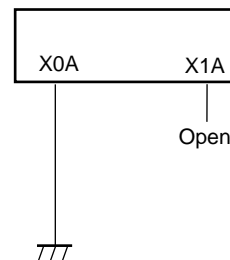
When a crystal or ceramic resonator is used



When an external clock is used



When a subclock is not used

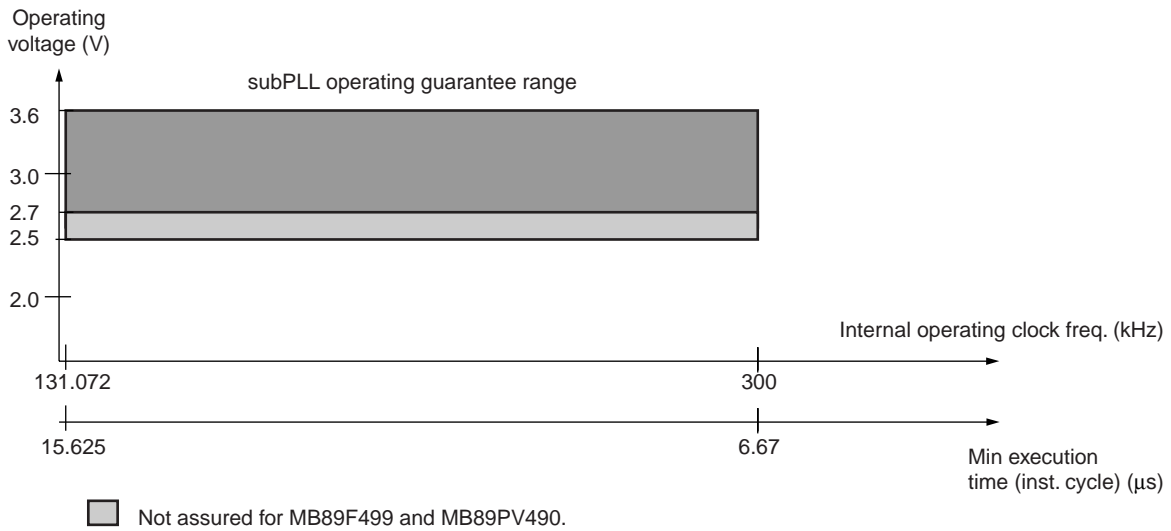


## (4) Instruction Cycle

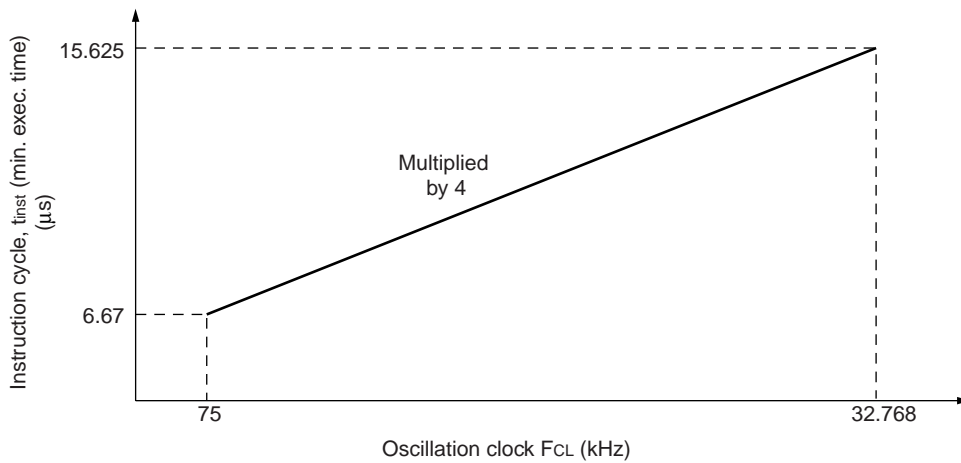
Parameter	Symbol	Value (typical)	Unit	Remarks
Instruction cycle (minimum execution time)	$t_{inst}$	$4/F_{CH}$ , $8/F_{CH}$ , $16/F_{CH}$ , $64/F_{CH}$	$\mu s$	$(4/F_{CH}) t_{inst} = 0.32 \mu s$ when operating at $F_{CH} = 12.5 \text{ MHz}$
		$2/F_{CL}$ , $1/2F_{CL}$	$\mu s$	$(2/F_{CL}) t_{inst} = 61.036 \mu s$ when operating at $F_{CL} = 32.768 \text{ kHz}$

- PLL operation guarantee range (sub PLL × 4)

Relationship between internal operating clock frequency and power supply voltage



Relationship between sub-clock oscillating frequency and instruction cycle when sub PLL is enabled



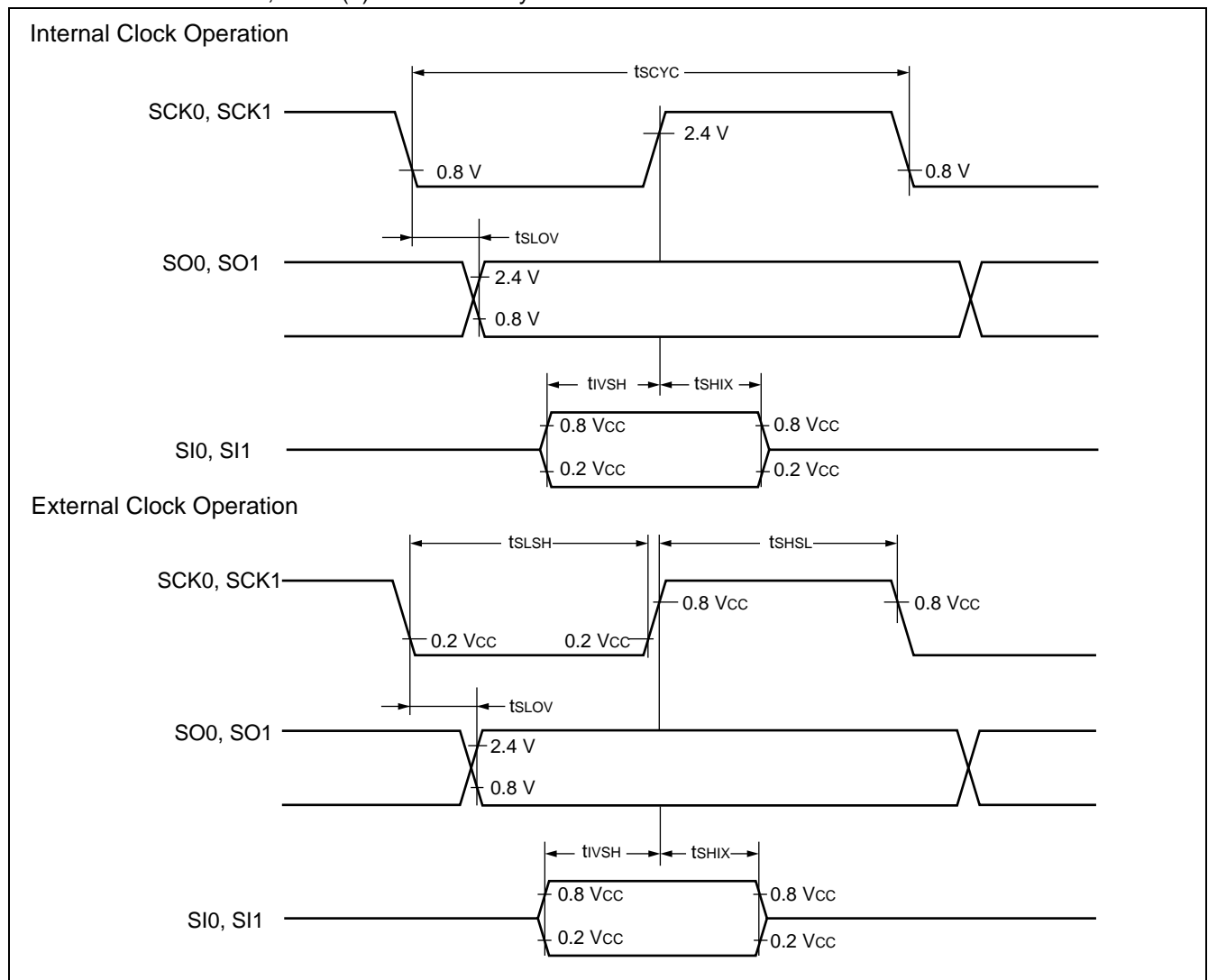
# MB89490 Series

## (5) Serial I/O Timing

( $AV_{CC} = V_{CC} = 3.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	$t_{SCYC}$	SCK0, SCK1	Internal shift clock mode	$2 t_{inst}^*$	—	$\mu\text{s}$
SCK $\downarrow \rightarrow$ SO time	$t_{SLOV}$	SCK0, SCK1, SO0, SO1		-200	200	ns
Valid SI $\rightarrow$ SCK $\uparrow$	$t_{IVSH}$	SI0, SI1, SCK0, SCK1		$1/2 t_{inst}^*$	—	$\mu\text{s}$
SCK $\uparrow \rightarrow$ valid SI hold time	$t_{SHIX}$	SCK0, SCK1, SI0, SI1		$1/2 t_{inst}^*$	—	$\mu\text{s}$
Serial clock "H" pulse width	$t_{SHSL}$	SCK0, SCK1	External shift clock mode	$1 t_{inst}^*$	—	$\mu\text{s}$
Serial clock "L" pulse width	$t_{SLSH}$			$1 t_{inst}^*$	—	$\mu\text{s}$
SCK $\downarrow \rightarrow$ SO time	$t_{SLOV}$	SCK0, SCK1, SO0, SO1		0	200	ns
Valid SI $\rightarrow$ SCK $\uparrow$	$t_{IVSH}$	SI0, SI1, SCK0, SCK1		$1/2 t_{inst}^*$	—	$\mu\text{s}$
SCK $\uparrow \rightarrow$ valid SI hold time	$t_{SHIX}$	SCK0, SCK1, SI0, SI1		$1/2 t_{inst}^*$	—	$\mu\text{s}$

\* : For information on  $t_{inst}$ , see "(4) Instruction Cycle".



## (6) I<sup>2</sup>C Timing

(V<sub>CC</sub> = 3.0V, AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = -40 °C to +85 °C)

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Start condition output	t <sub>STA</sub>	SCL SDA	$\frac{1}{4} t_{inst}^{*1} \times M \times N - 20$	$\frac{1}{4} t_{inst} \times M \times N + 20$	ns	At master mode
Stop condition output	t <sub>STO</sub>	SCL SDA	$\frac{1}{4} t_{inst} \times (M \times N + 8) - 20$	$\frac{1}{4} t_{inst} \times (M^{*2} \times N^{*3} + 8) + 20$	ns	At master mode
Start condition detect	t <sub>STA</sub>	SCL SDA	$\frac{1}{4} t_{inst} \times 6 + 40$	—	ns	
Stop condition detect	t <sub>STO</sub>	SCL SDA	$\frac{1}{4} t_{inst} \times 6 + 40$	—	ns	
Re-start condition output	t <sub>STASU</sub>	SCL SDA	$\frac{1}{4} t_{inst} \times (M \times N + 8) - 20$	$\frac{1}{4} t_{inst} \times (M \times N + 8) + 20$	ns	At master mode
Re-start condition detect	t <sub>STASU</sub>	SCL SDA	$\frac{1}{4} t_{inst} \times 4 + 40$	—	ns	
SCL output LOW width	t <sub>LOW</sub>	SCL	$\frac{1}{4} t_{inst} \times M \times N - 20$	$\frac{1}{4} t_{inst} \times M \times N + 20$	ns	At master mode
SCL output HIGH width	t <sub>HIGH</sub>	SCL	$\frac{1}{4} t_{inst} \times (M \times N + 8) - 20$	$\frac{1}{4} t_{inst} \times (M \times N + 8) + 20$	ns	At master mode
SDA output delay	t <sub>DO</sub>	SDA	$\frac{1}{4} t_{inst} \times 4 - 20$	$\frac{1}{4} t_{inst} \times 4 + 20$	ns	
SDA output setup time after interrupt	t <sub>DOSU</sub>	SDA	$\frac{1}{4} t_{inst} \times 4 - 20$	—	ns	*4
SCL input LOW pulse width	t <sub>LOW</sub>	SCL	$\frac{1}{4} t_{inst} \times 6 + 40$	—	ns	
SCL input HIGH pulse width	t <sub>HIGH</sub>	SCL	$\frac{1}{4} t_{inst} \times 2 + 40$	—	ns	
SDA input setup time	t <sub>SU</sub>	SDA	40	—	ns	
SDA hold time	t <sub>HO</sub>	SDA	0	—	ns	

\*1 : For information in t<sub>inst</sub>, see “(4) Instruction Cycle”.

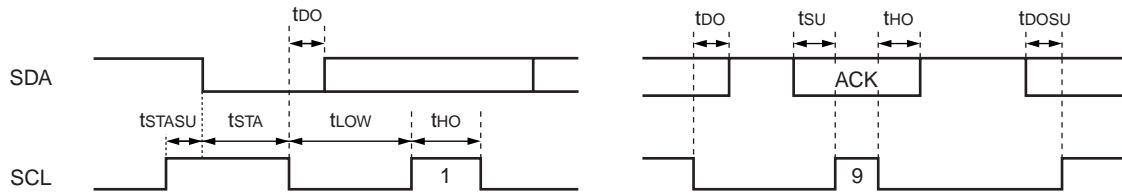
\*2 : M is defined in the I<sup>2</sup>C clock control register ICCR bit 4 and bit 3 (CS4 and CS3). For details, please refer to the H/W manual register explanation.

\*3 : N is defined in the I<sup>2</sup>C clock control register ICCR bit 2 to bit 0 (CS2 to CS0).

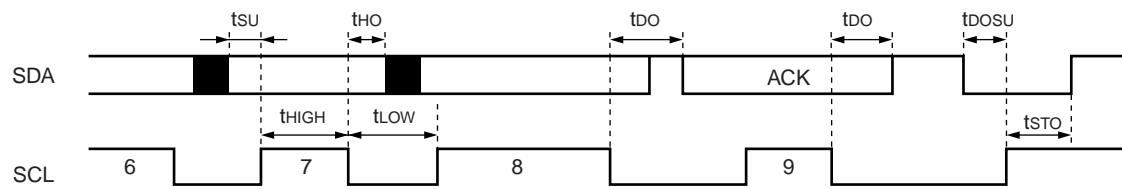
\*4 : When the interrupt period is greater than SCL “L” width, SDA and SCL output (Standard) value is based on hypothesis when rising time is 0 ns.

# MB89490 Series

## Data transmit (master/slave)



## Data receive (master/slave)



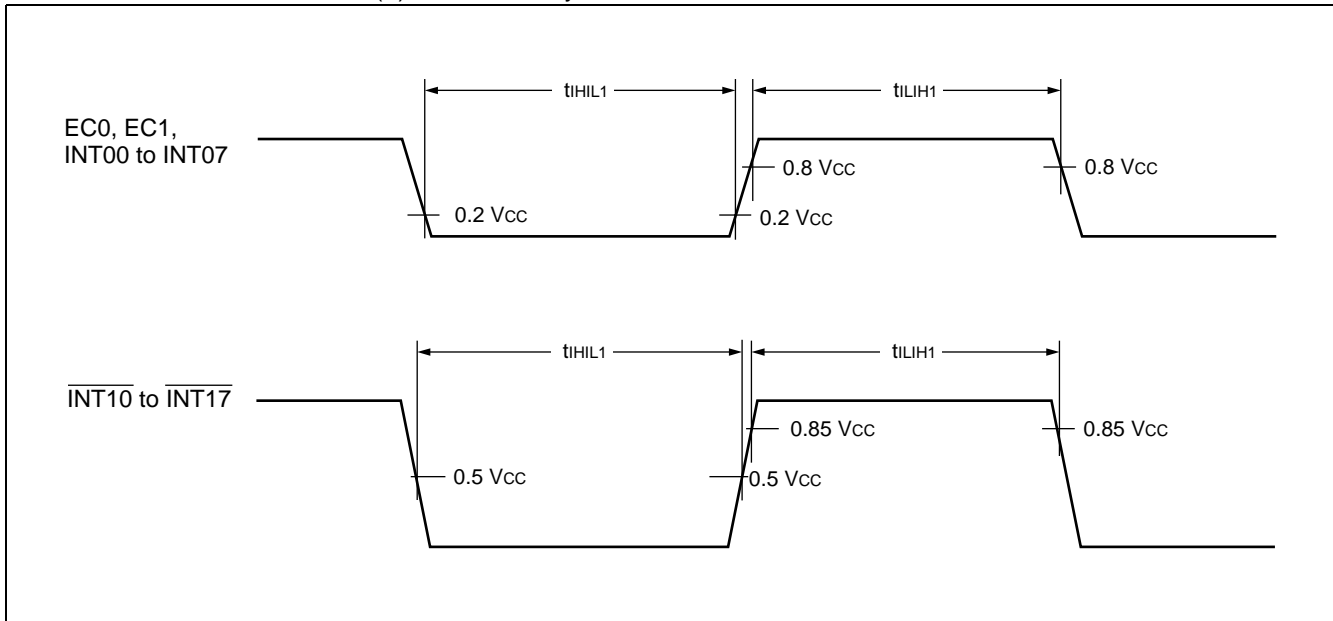


## (7) Peripheral Input Timing

( $AV_{CC} = V_{CC} = 3.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Peripheral input "H" pulse width 1	$t_{LIH1}$	EC0, EC1, INT00 to INT07, $\overline{\text{INT10}}$ to $\overline{\text{INT17}}$	$2 t_{inst}^*$	—	$\mu\text{S}$	
Peripheral input "L" pulse width 1	$t_{HIL1}$		$2 t_{inst}^*$	—	$\mu\text{S}$	

\* : For information on  $t_{inst}$ , see "(4) Instruction Cycle".



# MB89490 Series

## 5. A/D Converter Electrical Characteristics

### (1) A/D Converter Electrical Characteristics

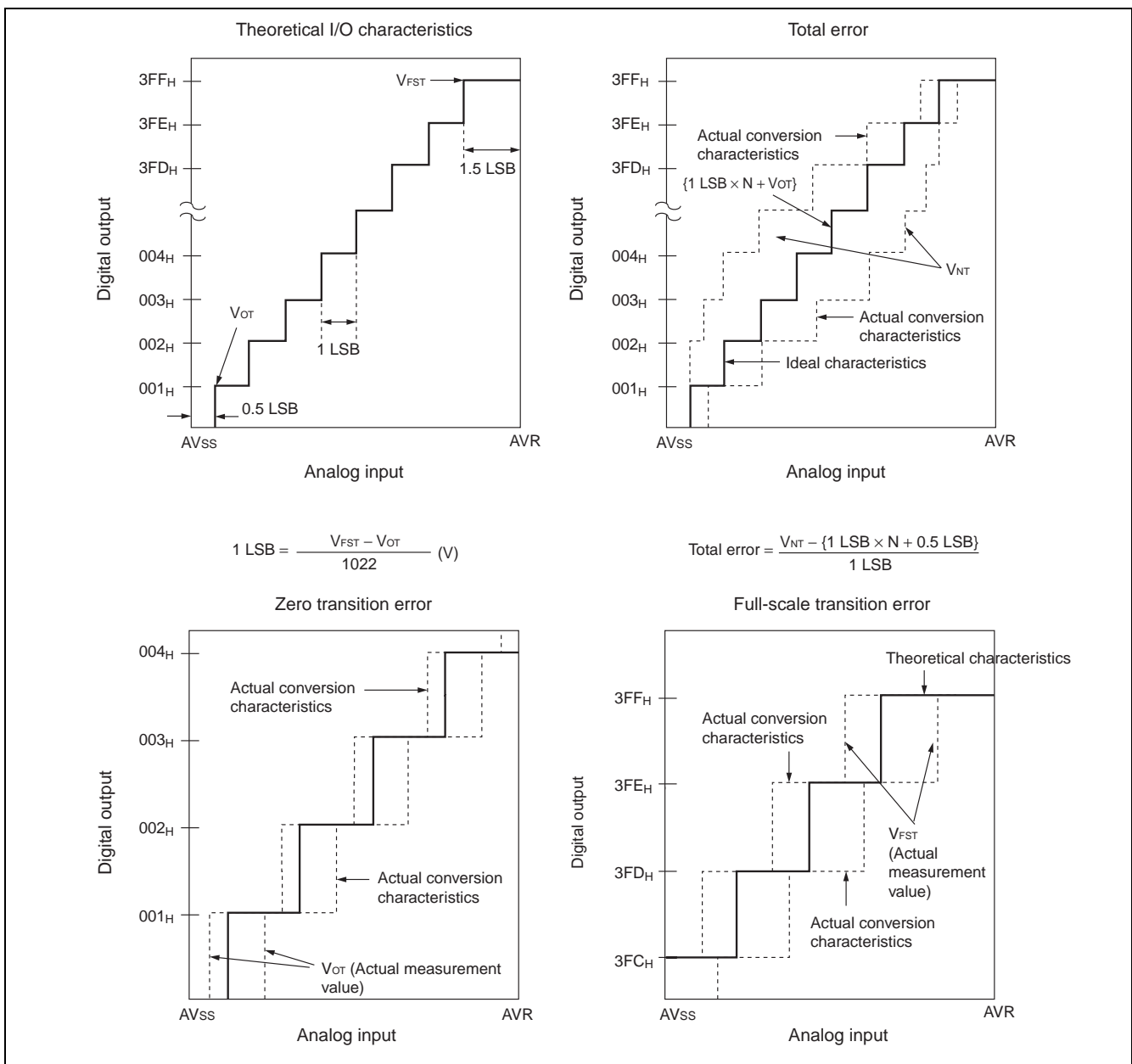
( $AV_{CC} = V_{CC} = 2.7\text{ V}$  to  $3.6\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	10	—	bit	
Total error			—	—	$\pm 3.0$	LSB	
Linearity error			—	—	$\pm 2.5$	LSB	
Differential linearity error			—	—	$\pm 1.9$	LSB	
Zero transition voltage	$V_{OT}$	—	$AV_{SS} - 1.5\text{ LSB}$	$AV_{SS} + 0.5\text{ LSB}$	$AV_{SS} + 2.5\text{ LSB}$	V	
Full-scale transition voltage	$V_{FST}$		$AVR - 3.5\text{ LSB}$	$AVR - 1.5\text{ LSB}$	$AVR - 0.5\text{ LSB}$	V	
A/D mode conversion time	—		$30\ t_{inst}^*$	—	—	$\mu\text{s}$	
Analog port input current	$I_{AIN}$	AN0 to AN7	—	—	10	$\mu\text{A}$	
Analog input voltage	$V_{AIN}$	AN7	$AV_{SS}$	—	AVR	V	
Reference voltage	—	AVR	$AV_{SS} + 2.7$	—	$AV_{CC}$	V	
Reference voltage supply current	$I_R$		—	95.0	170.0	$\mu\text{A}$	A/D is activated
	$I_{RH}$		—	—	4.0	$\mu\text{A}$	A/D is stopped

\* : For information on  $t_{inst}$ , see “(4) Instruction Cycle” in “4. AC Characteristics”.

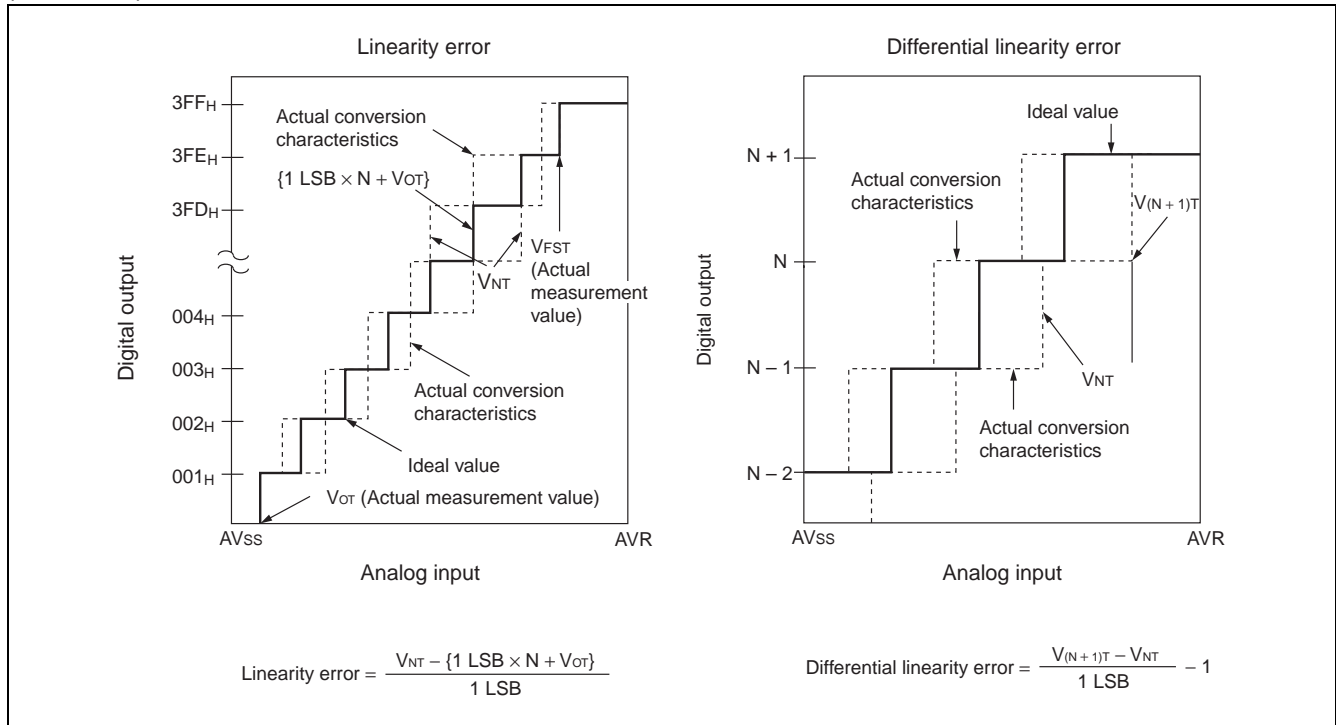
## (2) A/D Converter Glossary

- Resolution  
Analog changes that are identifiable with the A/D converter.  
When the number of bits is 10, analog voltage can be divided into  $2^{10} = 1024$ .
- Linearity error (unit : LSB)  
The deviation of the straight line connecting the zero transition point (“00 0000 0000” ↔ “00 0000 0001”) with the full-scale transition point (“11 1111 1111” ↔ “11 1111 1110”) from actual conversion characteristics.
- Differential linearity error (unit : LSB)  
The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value.
- Total error (unit : LSB)  
The difference between theoretical and actual conversion values.



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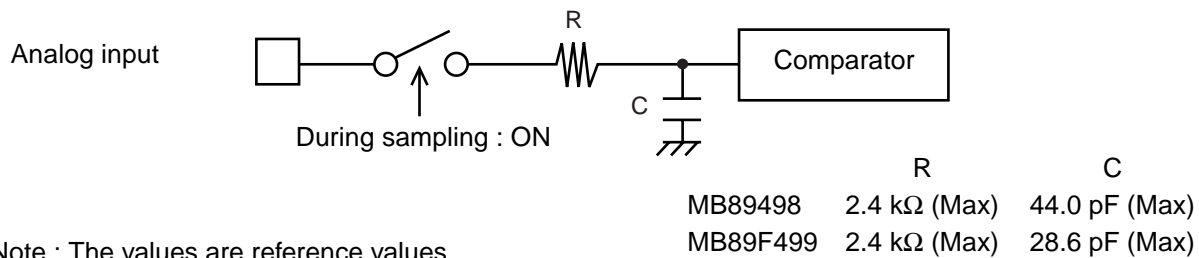


## (3) Notes on Using A/D Converter

### • About the external impedance of the analog input and its sampling time

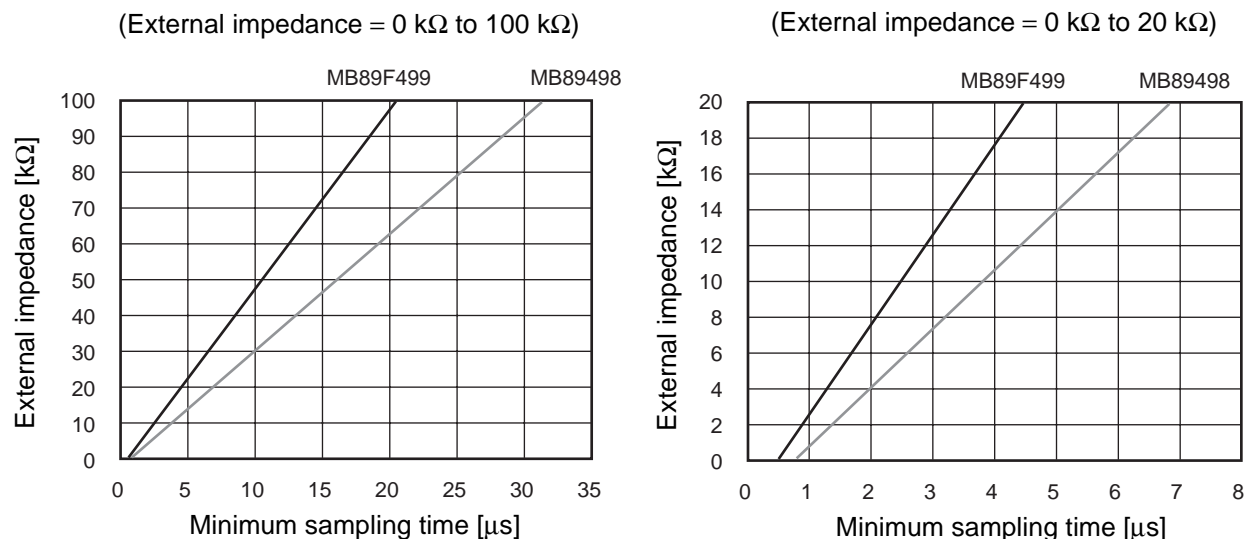
- A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision.

#### • Analog input circuit model



- To satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the resistor value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value.

#### • The relationship between external impedance and minimum sampling time

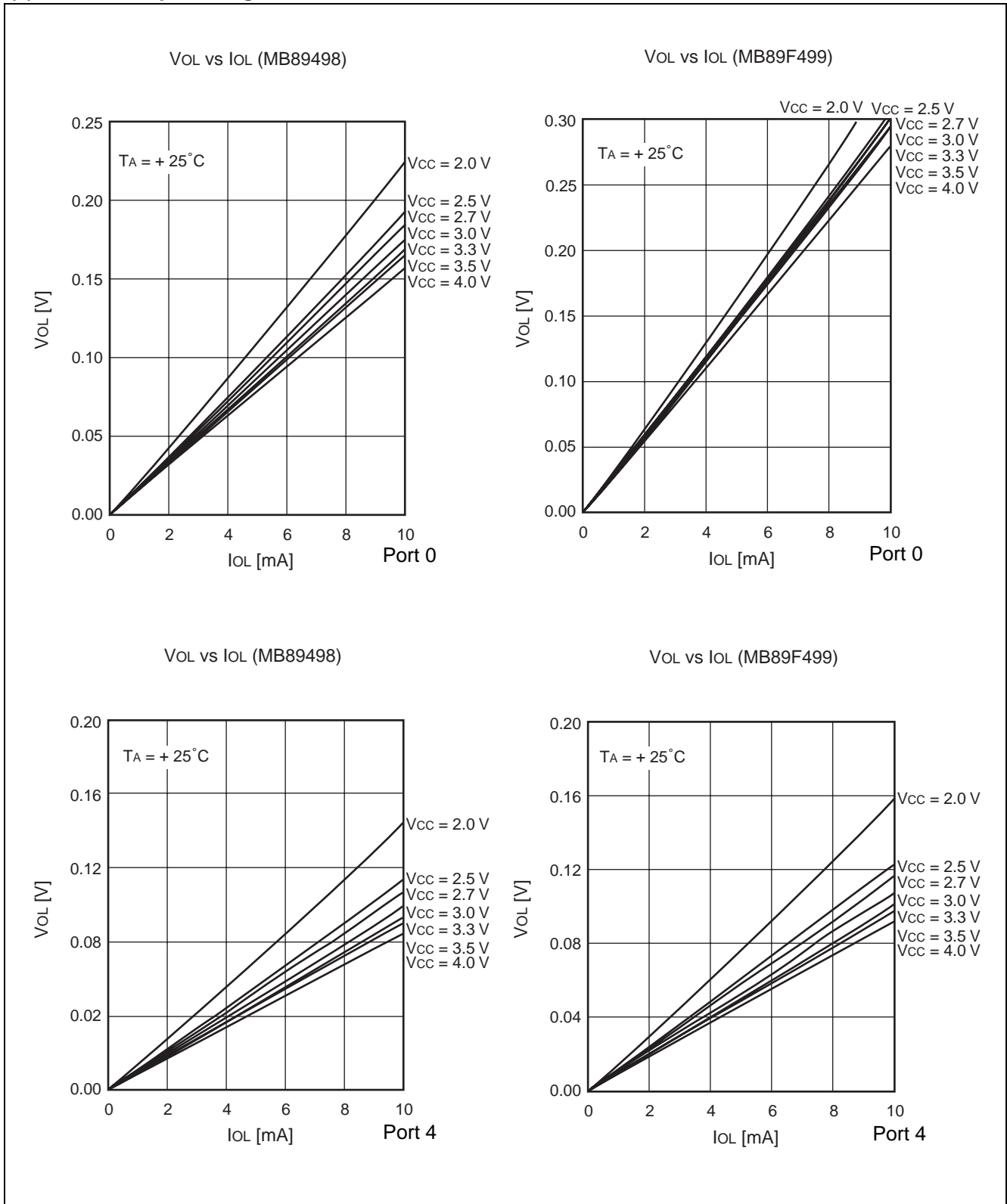


- If the sampling time cannot be sufficient, connect a capacitor of about 0.1 μF to the analog input pin.
- About errors  
As  $|AVRH - AV_{SS}|$  becomes smaller, values of relative errors grow larger.

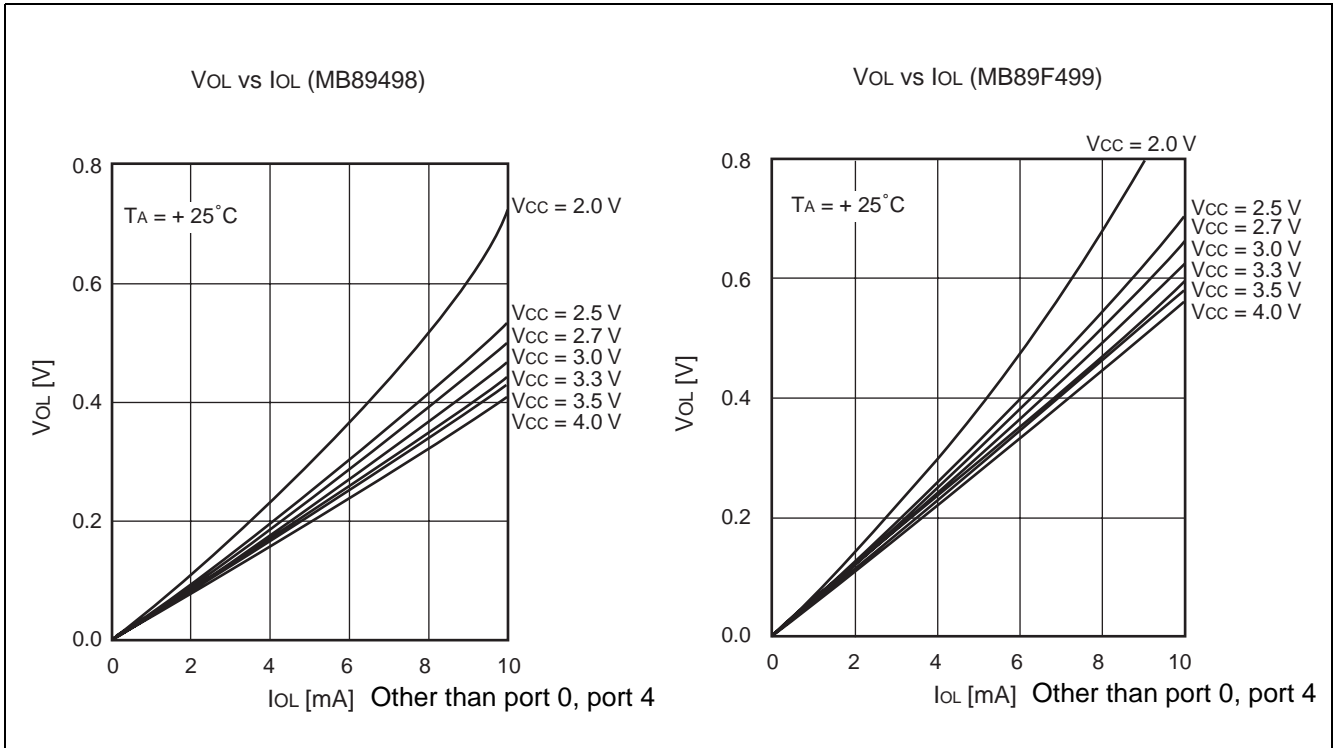
# MB89490 Series

## EXAMPLE CHARACTERISTICS

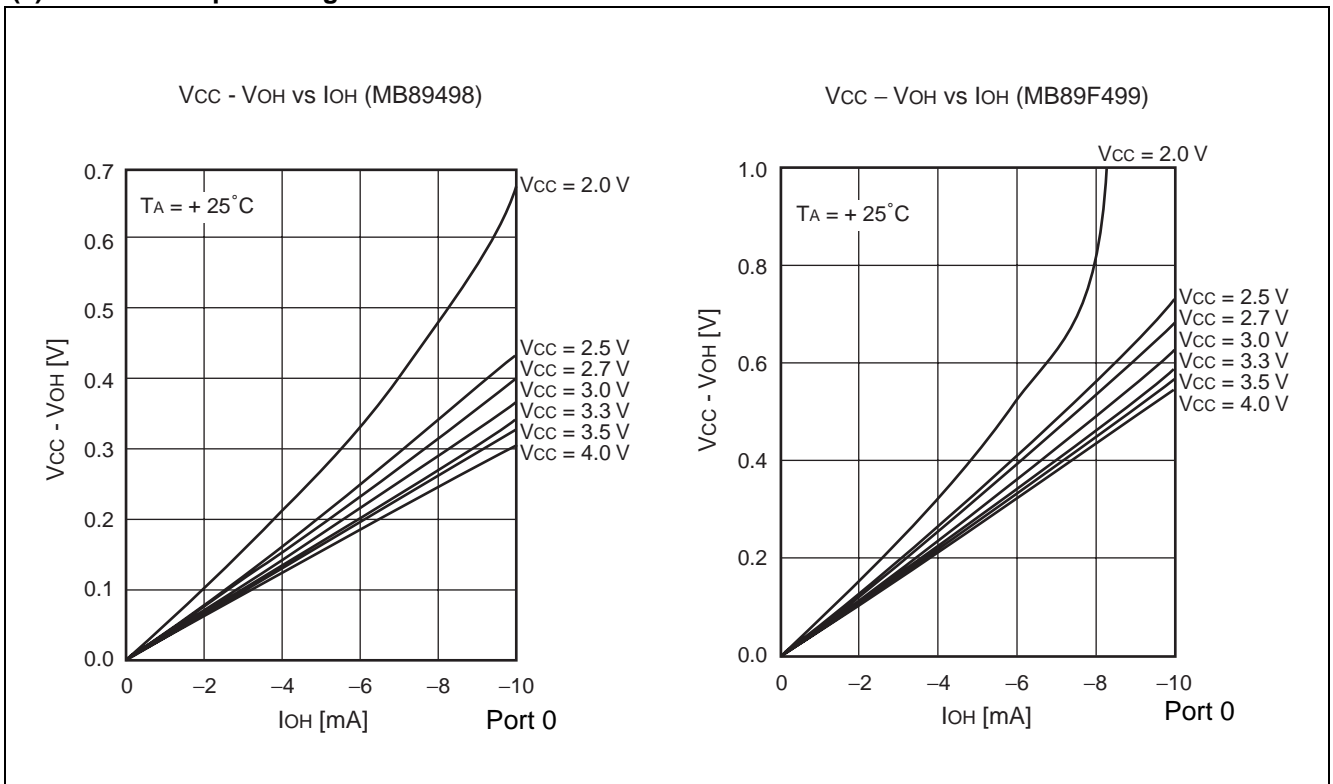
### (1) "L" level output voltage



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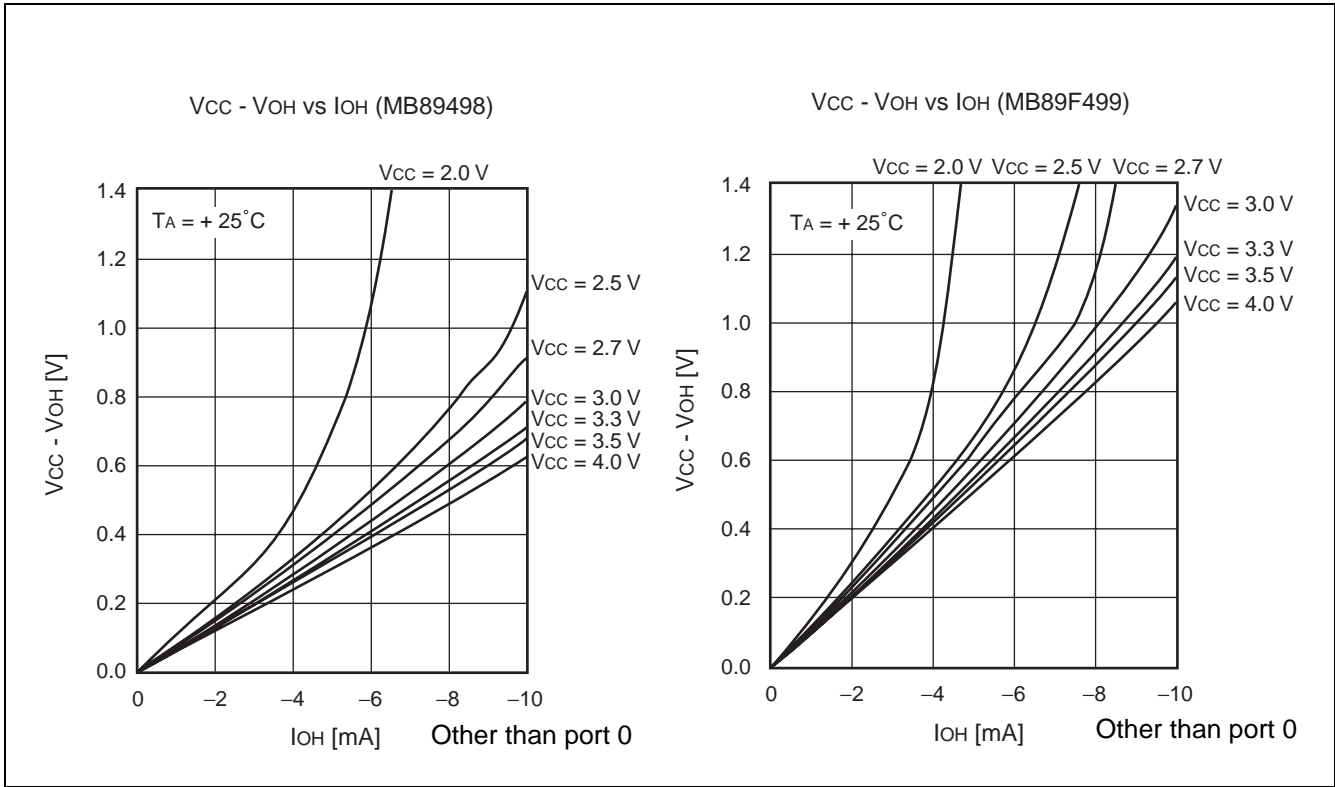


## (2) "H" level output voltage

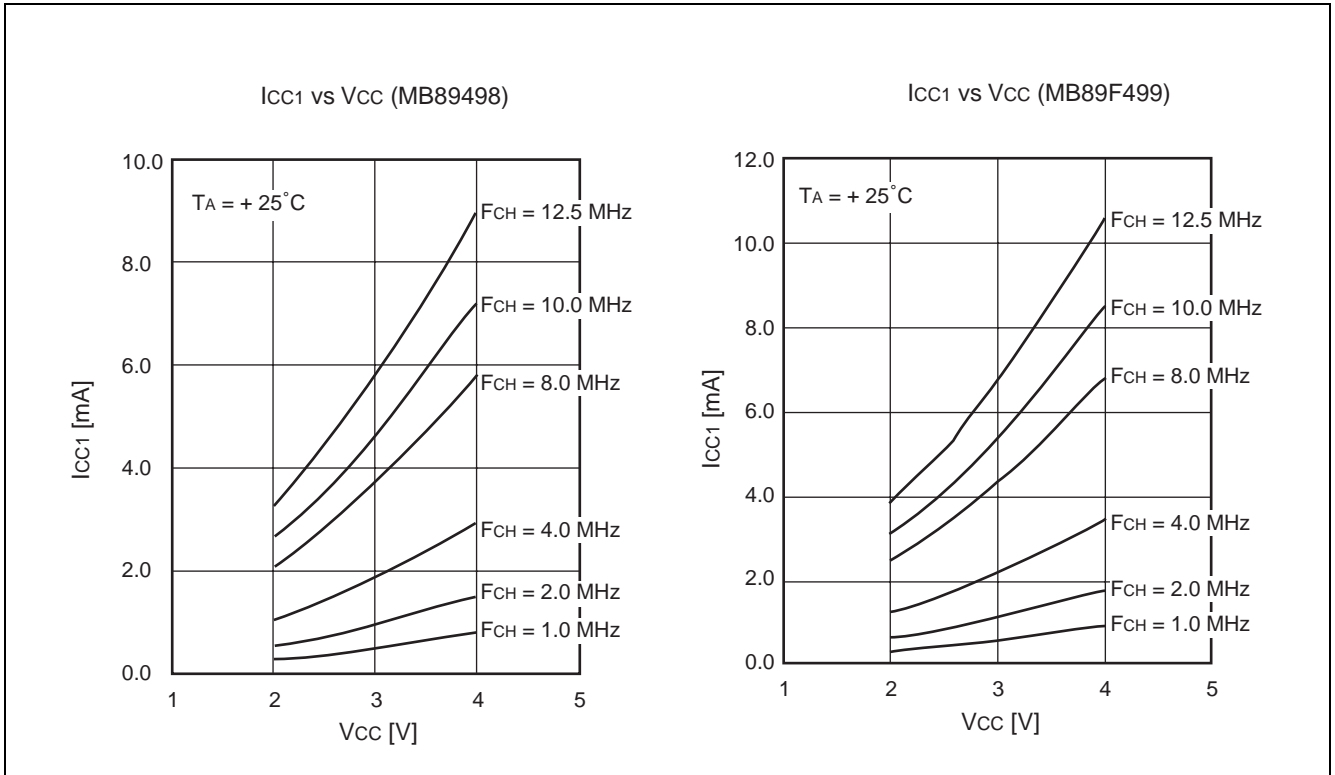


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# MB89490 Series



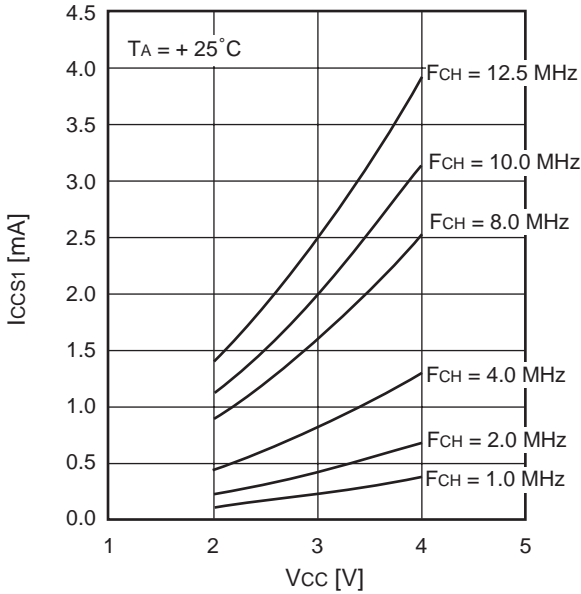
### (3) Power supply current (External clock)



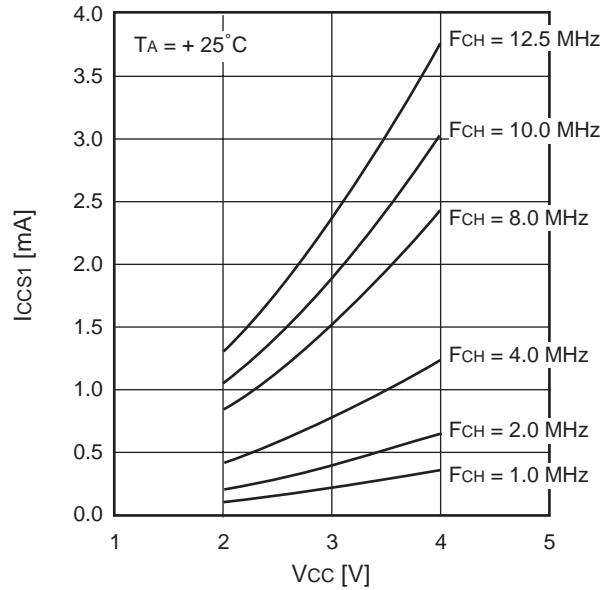
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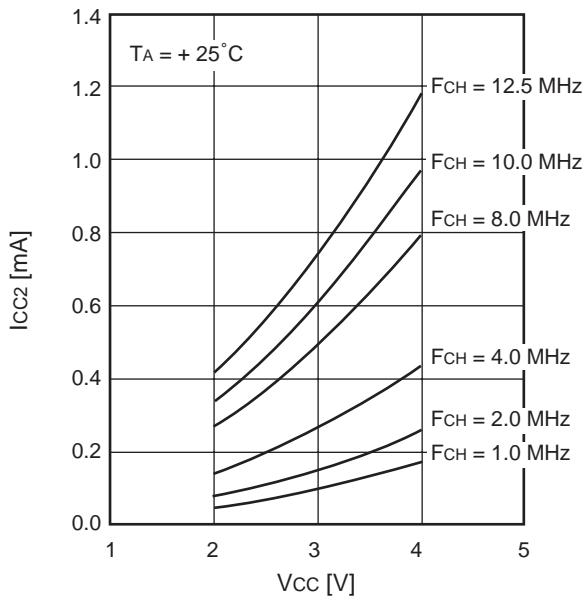
ICCS1 vs VCC (MB89498)



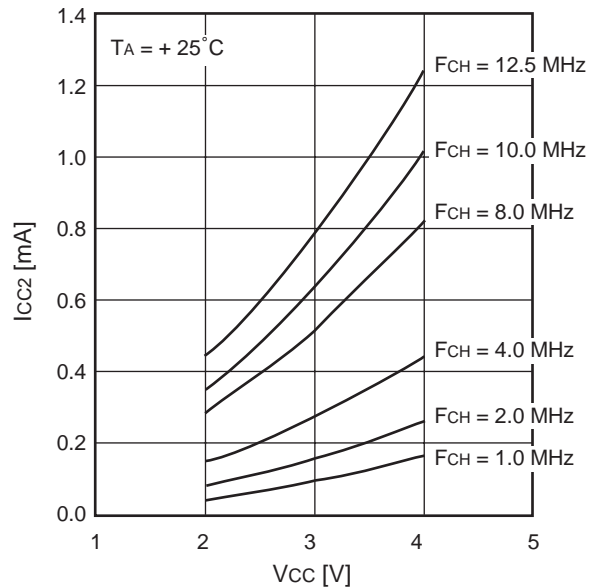
ICCS1 vs VCC (MB89F499)



ICC2 vs VCC (MB89498)



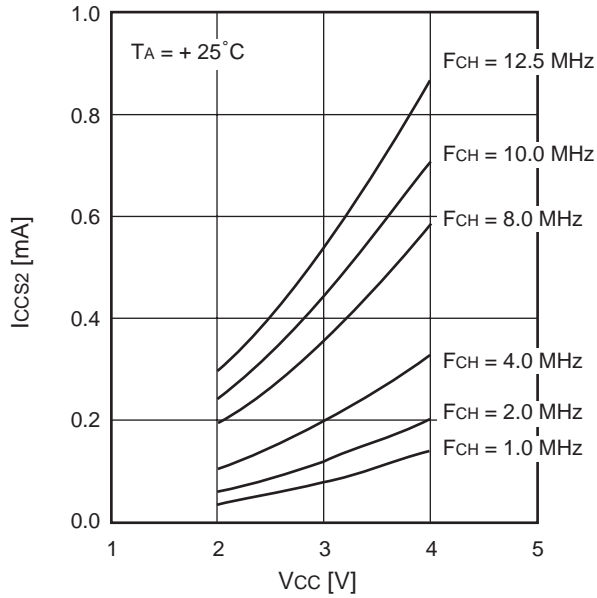
ICC2 vs VCC (MB89F499)



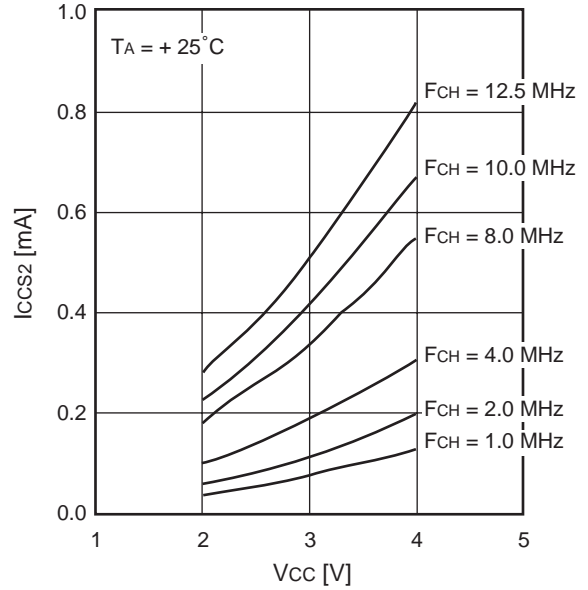
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# MB89490 Series

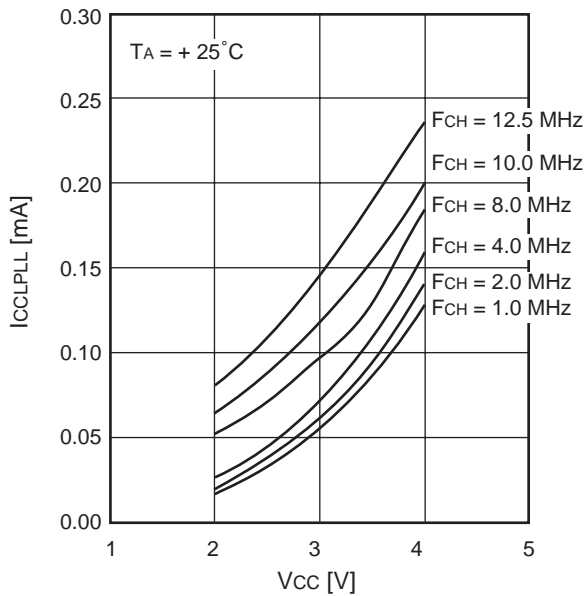
I<sub>CCS2</sub> vs V<sub>CC</sub> (MB89498)



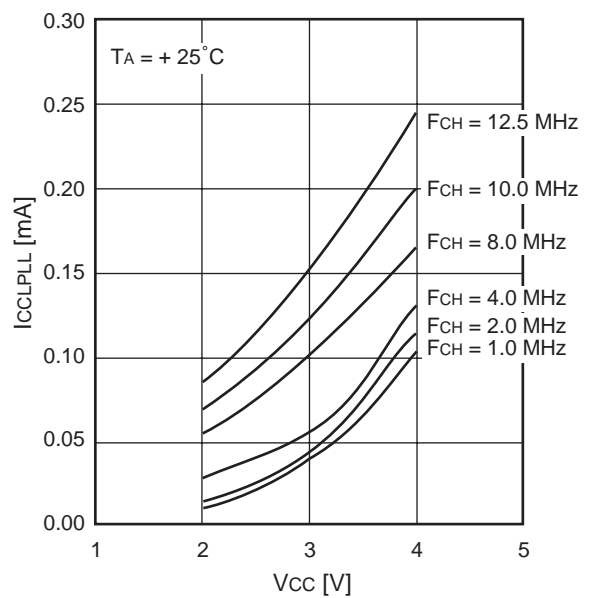
I<sub>CCS2</sub> vs V<sub>CC</sub> (MB89F499)



I<sub>CLPLL</sub> vs V<sub>CC</sub> (MB89498)

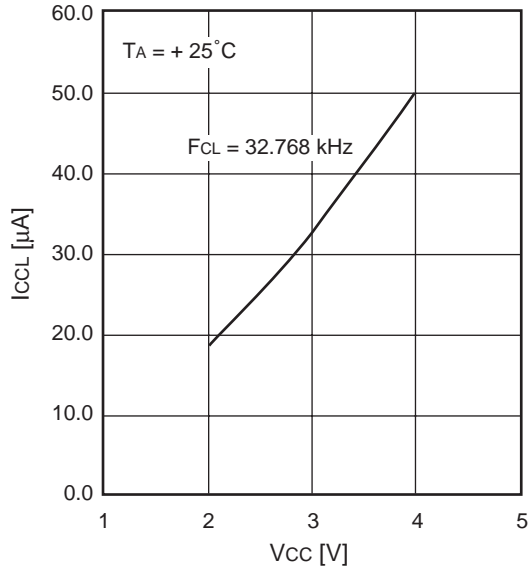


I<sub>CLPLL</sub> vs V<sub>CC</sub> (MB89F499)

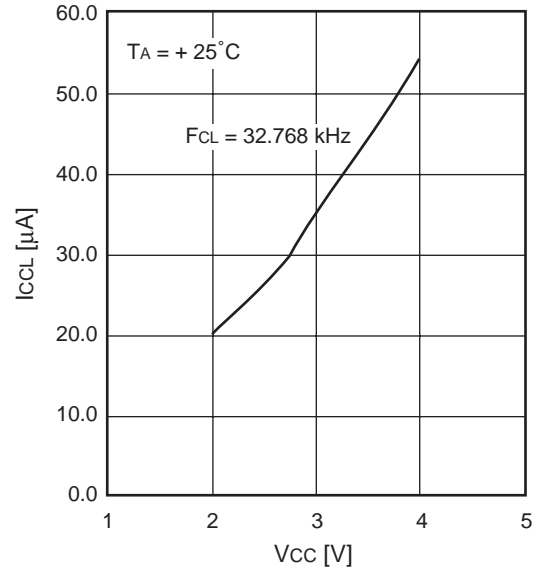


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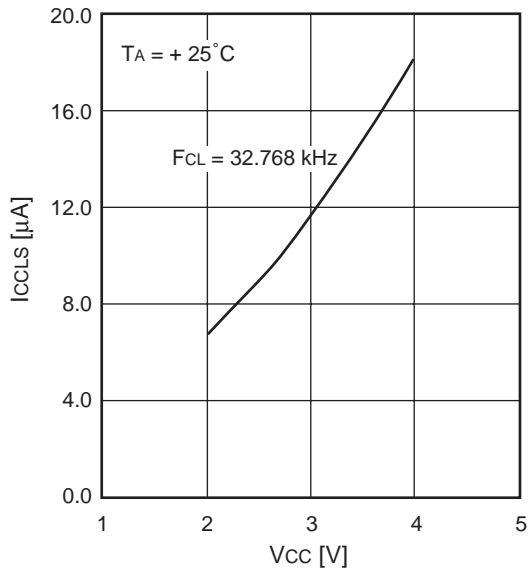
ICCL vs VCC (MB89498)



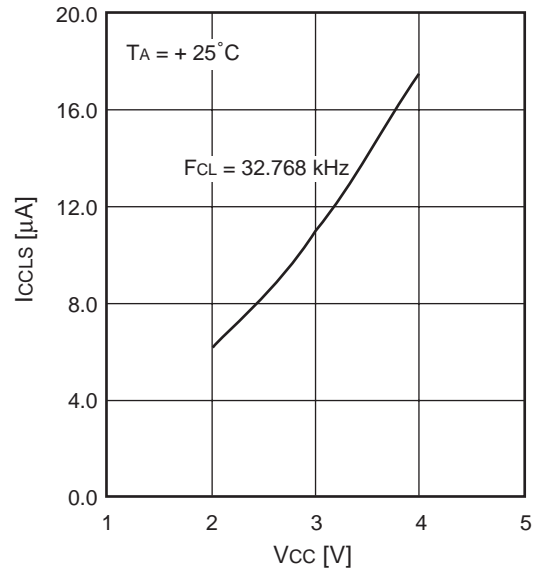
ICCL vs VCC (MB89F499)



ICCLS vs VCC (MB89498)



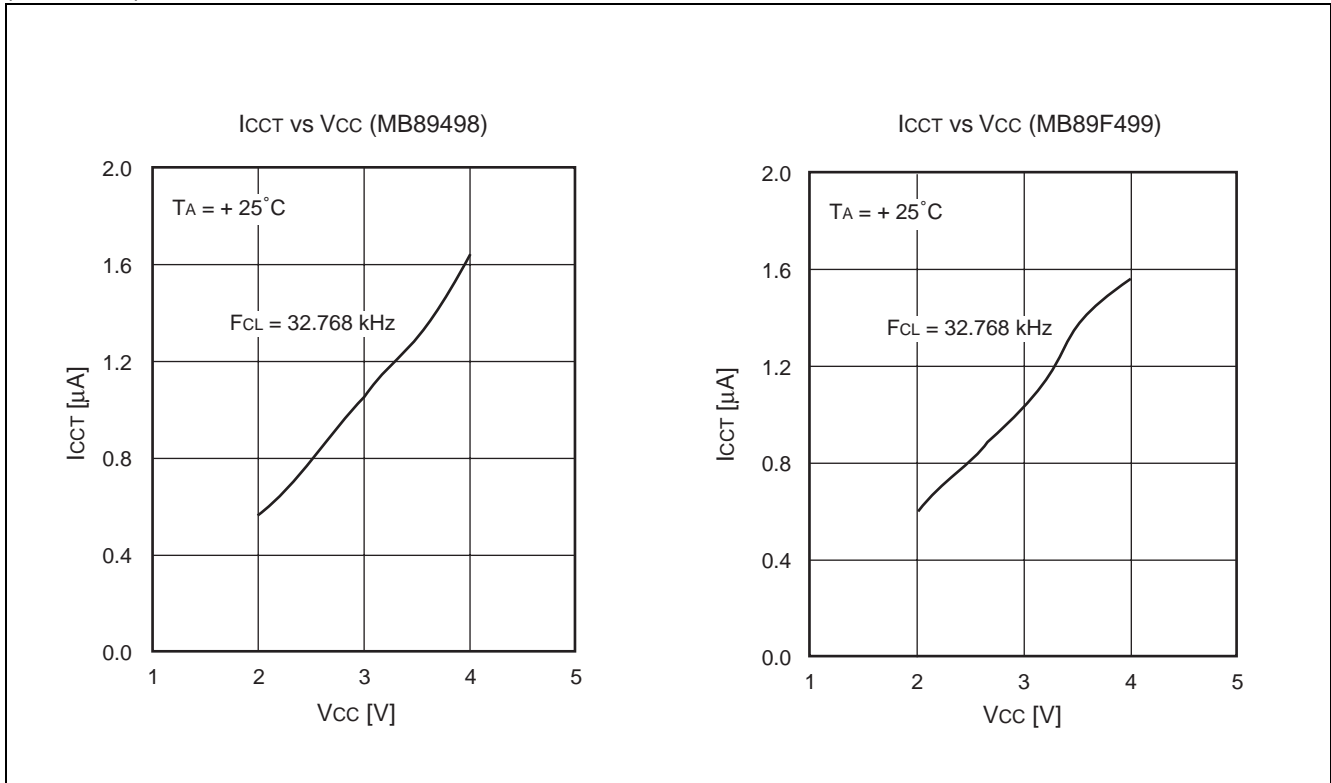
ICCLS vs VCC (MB89F499)



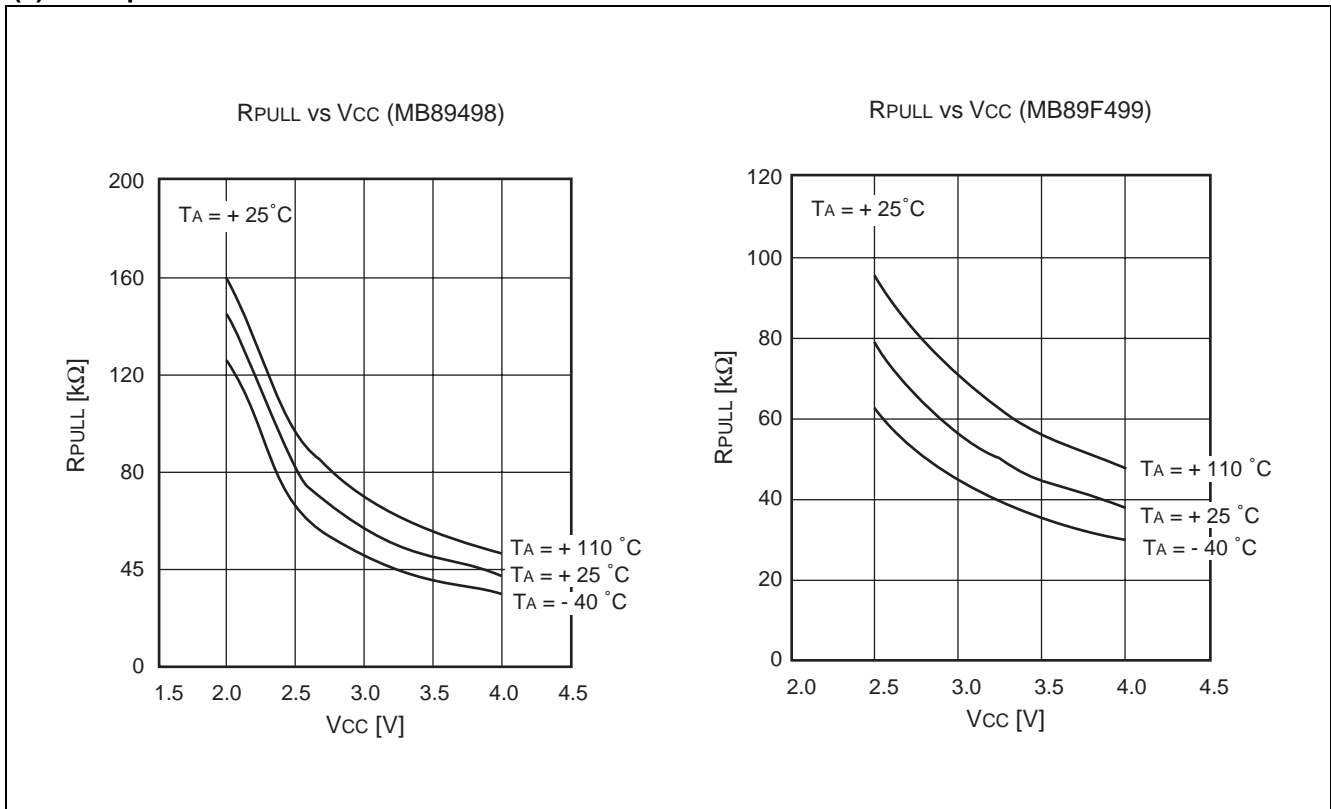
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# MB89490 Series

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## (4) Pull-up resistance



## ■ MASK OPTIONS

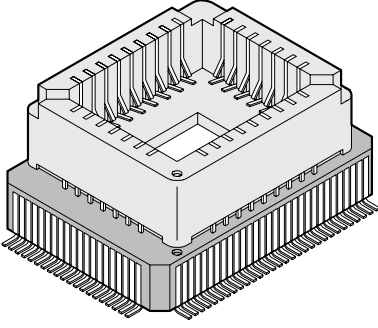
Part number	MB89498	MB89F499	MB89PV490
<b>Specifying procedure</b>	<b>Specify when ordering mask</b>	<b>Setting not possible</b>	
Main clock oscillation stabilization time selection $2^{10}/F_{CH}$ $2^{14}/F_{CH}$ $2^{18}/F_{CH}$	Selectable	Fixed to oscillation stabilization wait time of $2^{18}/F_{CH}$	

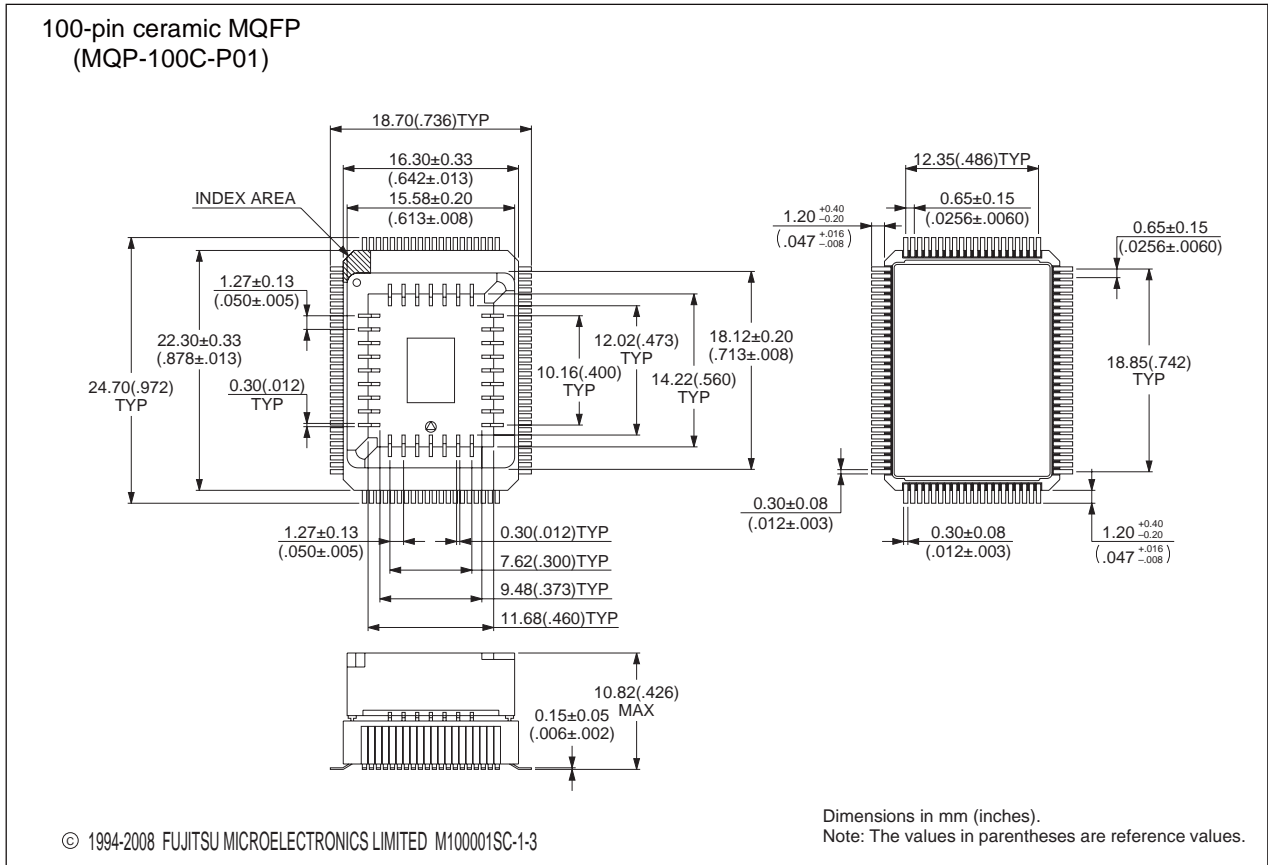
## ■ ORDERING INFORMATION

Part number	Package	Remarks
MB89498PF MB89F499PF	100-pin Plastic QFP (FPT-100P-M06)	
MB89498PMC MB89F499PMC	100-pin Plastic LQFP (FPT-100P-M20)	
MB89PV490CF	100-pin Ceramic MQFP (MQP-100C-P01)	

# MB89490 Series

## PACKAGE DIMENSIONS

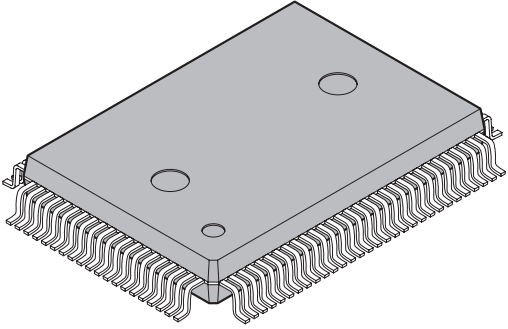
<p>100-pin ceramic MQFP</p>  <p>(MQP-100C-P01)</p>	Lead pitch	0.65 mm
	Lead shape	Straight
	Motherboard material	Ceramic
	Mounted package material	Plastic

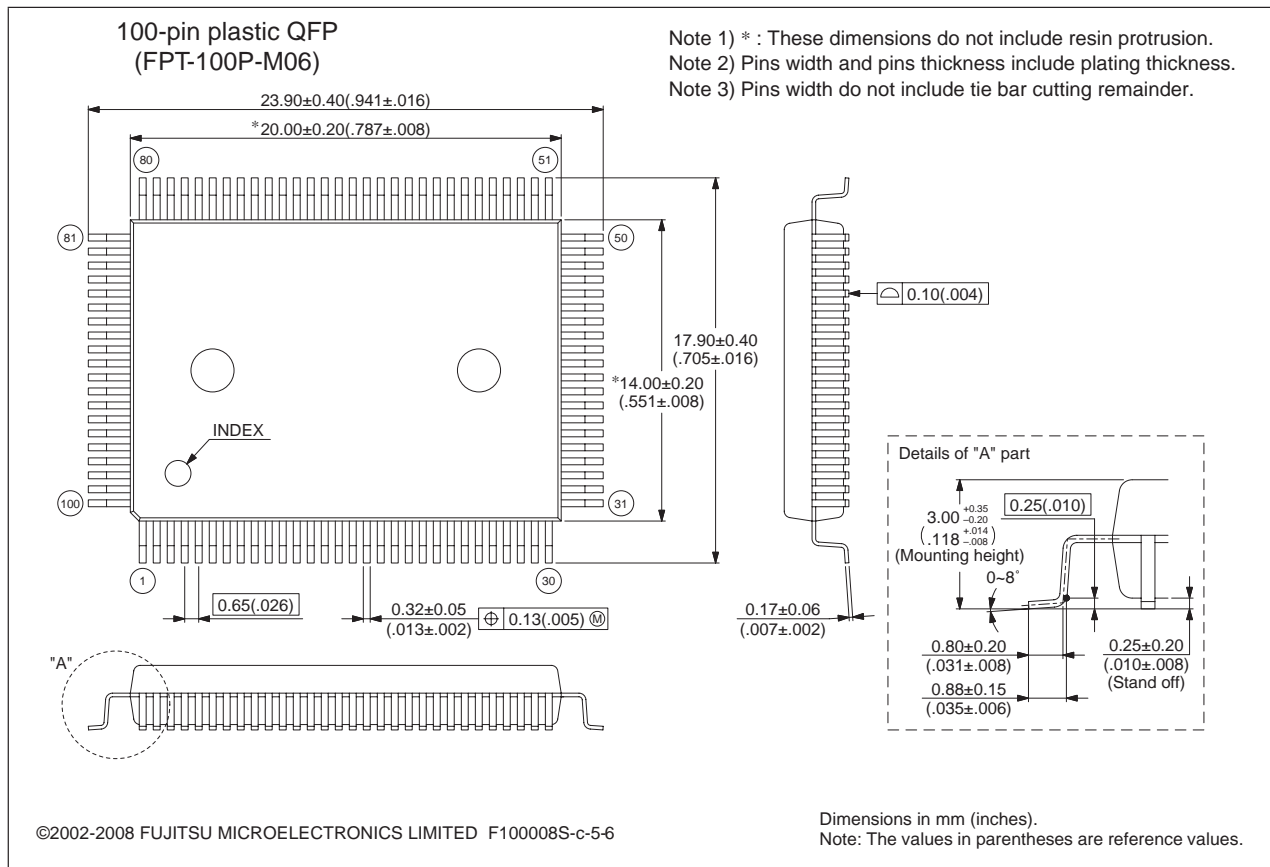


Please confirm the latest Package dimension by following URL.  
<http://edevic.fujitsu.com/package/en-search/>

(Continued)

# MB89490 Series

<p>100-pin plastic QFP</p>  <p>(FPT-100P-M06)</p>	Lead pitch	0.65 mm
	Package width × package length	14.00 × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65

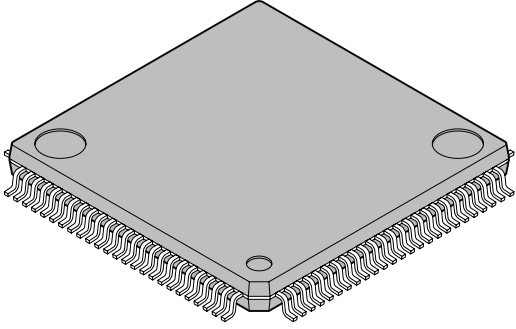


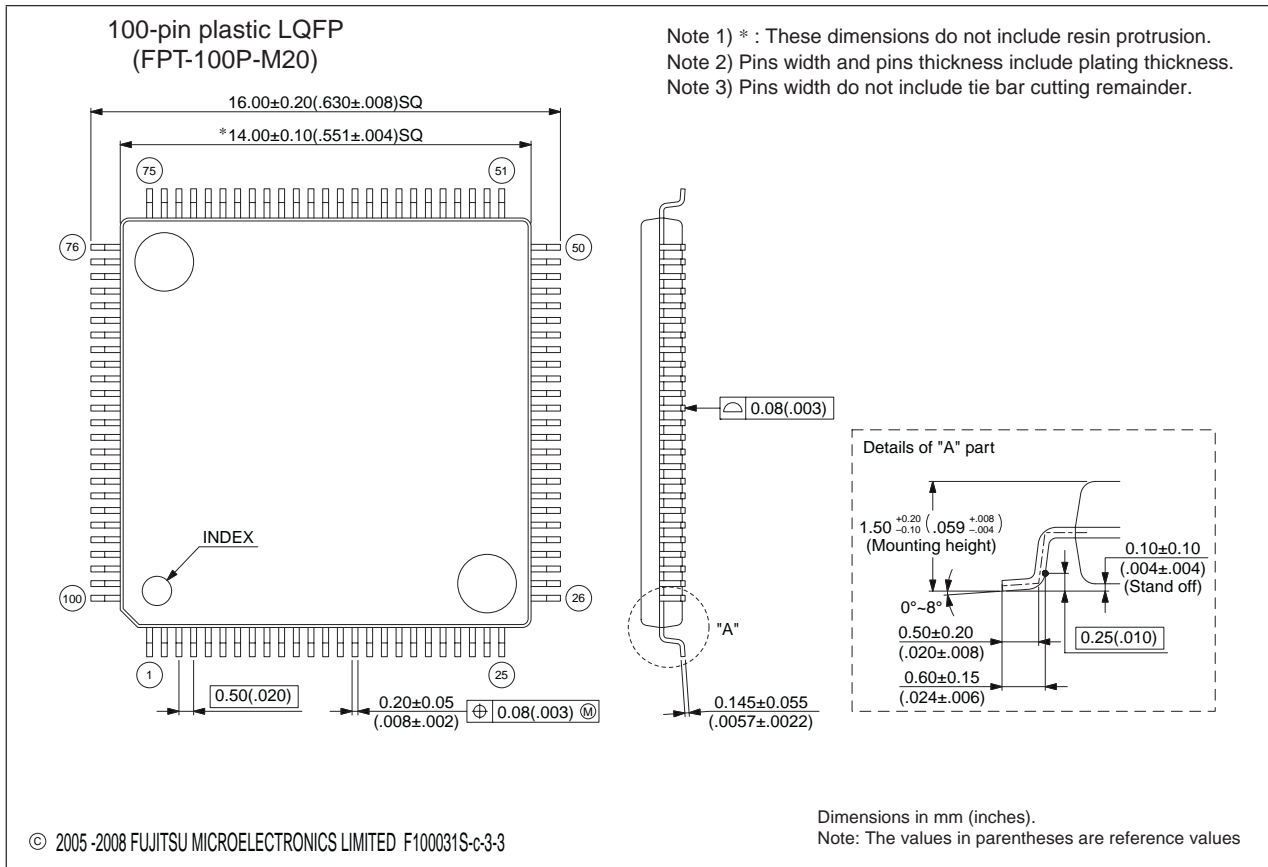
Please confirm the latest Package dimension by following URL.  
<http://edevic.fujitsu.com/package/en-search/>

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# MB89490 Series

(Continued)

<p>100-pin plastic LQFP</p>  <p>(FPT-100P-M20)</p>	Lead pitch	0.50 mm
	Package width × package length	14.0 mm × 14.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm Max
	Weight	0.65 g
	Code (Reference)	P-LFQFP100-14×14-0.50



Please confirm the latest Package dimension by following URL.  
<http://edevice.fujitsu.com/package/en-search/>



## ■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
—	—	The package code is changed. FPT-100P-M05 → FPT-100P-M20
16	■ PROGRAMMING AND ERASING FLASH MEMORY ON THE MB89F499	Deleted the “6. ROM Programmer Adaptor and Recommended ROM Programmers”
17	■ PROGRAMMING TO THE EPROM WITH PIGGY-BACK/EVALUATION DEVICE	Deleted the “2. Programming Socket Adapter”
	■ ICE PROBE POD ADAPTOR OF PIGGY-BACK/EVA CHIP	Deleted the “■ ICE PROBE POD ADAPTOR OF PIGGY-BACK/EVA CHIP”
42	■ ELECTRICAL CHARACTERISTICS 5. A/D Converter Electrical Characteristics	Changed the items of “Zero transition voltage” and “Full-scale transition voltage”. mV → V AV <sub>CC</sub> → AVR
53	■ ORDERING INFORMATION	Order informations are changed. MB89498PFV → MB89498PMC MB89F499PFV → MB89F499PMC
56	■ PACKAGE DIMENSIONS	The package code is changed. FPT-100P-M05 → FPT-100P-M20

The vertical lines marked in the left side of the page show the changes.

**MEMO**

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# MB89490 Series

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